

FT25H64 DATASHEET



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1. FEATURES

- 64M -bit Serial Flash
 - 8192K-byte
 - 256 bytes per programmable page
- Standard, Dual, Quad SPI
 - Standard SPI: SCLK, CS#, SI, SO, WP#, HOLD#
 - Dual SPI: SCLK, CS#, IO0, IO1, WP#, HOLD#
 - Quad SPI: SCLK, CS#, IO0, IO1, IO2, IO3
 - QPI: SCLK, CS#, IO0, IO1, IO2, IO3
- High Speed Clock Frequency
 - 108MHz for fast read with 30PF load
 - Dual I/O Data transfer up to 216Mbits/s
 - Quad I/O Data transfer up to 432Mbits/s
 - QPI Mode Data transfer up to 384Mbits/s
 - Continuous Read With 8/16/32/64byte Wrap
- Program/Erase Speed
 - Page Program time: 250uS typical
 - Sector Erase time: 50ms typical
 - Block Erase time: 0.15/0.25s typical
 - Chip Erase time: 20s typical

■ Flexible Architecture

- Sector of 4K-byte
- Block of 32/64k-byte
- Erase/Program Suspend/Resume

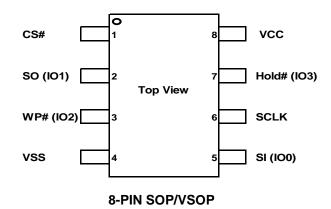
- Low Power Consumption
 - 20mA maximum active current
 - 0.2uA maximum power down current
- Software/Hardware Write Protection
 - Write protect all/portion of memory via software
 - Enable/Disable protection with WP# Pin
 - Top or Bottom, Sector or Block selection
- Advanced security Features
 - 4*256-Byte Security Registers With OTP Lock
- Single Power Supply Voltage: Full voltage range:2.7~3.6V
- Typical 100,000 Program/Erase Cycle
- Hardware Features
 - 8-pin SOP8 (150mil)
 - 8-pin SOP8 (208mil)
- Temperature Grade
 - Default Industrial grade (- 40 °C to + 85 °C)



2. GENERAL DESCRIPTION

The FT25H64 (64M-bit) Serial flash supports the standard Serial Peripheral Interface (SPI), and supports the Dual/Quad SPI: Serial Clock, Chip Select, Serial Data I/O0 (SI), I/O1 (SO), I/O2 (WP#), and I/O3 (HOLD#). The Dual I/O data is transferred with speed of 240Mbits/s and the Quad I/O & Quad output data is transferred with speed of 432Mbits/s.

CONNECTION DIAGRAM

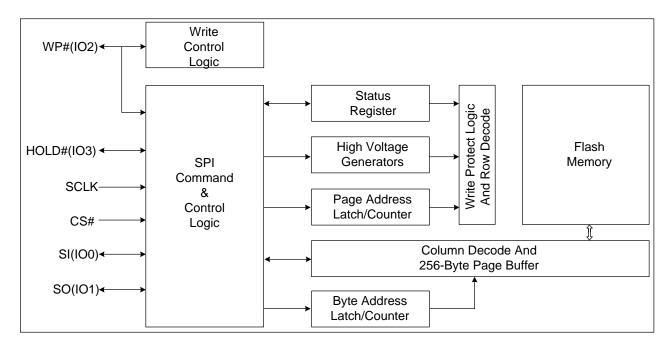


PIN DESCRIPTION

Pin Name I/O		Description
CS#	I	Chip Select Input
SO (IO1)	I/O	Data Output (Data Input Output 1)
WP# (IO2) I/O		Write Protect Input (Data Input Output 2)
VSS		Ground
SI (IO0)	I/O	Data Input (Data Input Output 0)
SCLK	I	Serial Clock Input
HOLD# (IO3)	I/O	Hold Input (Data Input Output 3)
VCC		Power Supply



BLOCK DIAGRAM





3. MEMORY ORGANIZATION

FT25H64

Each Device has	Each block has	Each sector has	Each page has	Remark
8M	64K/32K	4K	256	bytes
32K	256/128	16	-	pages
2K	16/8	-	-	sectors
256/128	-	-	-	blocks

UNIFORM BLOCK SECTOR ARCHITECTURE FT25H64 64K Bytes Block Sector Architecture

Block	Sector	Addres	ss range
	2047	7FF000H	7FFFFH
127			
	2032	7F0000H	7F0FFFH
	2031	7EF000H	7EFFFFH
126			
	2016	7E0000H	7E0FFFH
	47	02F000H	02FFFFH
2			
	32	020000H	020FFFH
	31	01F000H	01FFFFH
1			
	16	010000H	010FFFH
	15	00F000H	00FFFFH
0			
	0	000000H	000FFFH



4. DEVICE OPERATION

Standard SPI

The FT25H64 features a serial peripheral interface on 4 signals bus: Serial Clock (SCLK), Chip Select (CS#), Serial Data Input (SI) and Serial Data Output (SO). Both SPI bus mode 0 and 3 are supported. Input data is latched on the rising edge of SCLK and data shifts out on the falling edge of SCLK.

Dual SPI

The FT25H64 supports Dual SPI operation when using the "Dual Output Fast Read" and "Dual I/O Fast Read" (3BH and BBH) commands. These commands allow data to be transferred to or from the device at two times the rate of the standard SPI. When using the Dual SPI command the SI and SO pins become bidirectional I/O pins: IO0 and IO1.

Quad SPI

The FT25H64 supports Quad SPI operation when using the "Quad Output Fast Read", "Quad I/O Fast Read", "Quad I/O Word Fast Read" (6BH, EBH, E7H) commands. These commands allow data to be transferred to or from the device at four times the rate of the standard SPI. When using the Quad SPI command the SI and SO pins become bidirectional I/O pins: IO0 and IO1, and WP# and HOLD# pins become IO2 and IO3. Quad SPI commands require the non-volatile Quad Enable bit (QE) in Status Register to be set.

QPI

The FT25H64 supports Quad Peripheral Interface (QPI) operations only when the device is switched from Standard/Dual/Quad SPI mode to QPI mode using the "Enable the QPI (38H)" command. The QPI mode utilizes all four IO pins to input the command code. Standard/Dual/Quad SPI mode and QPI mode are exclusive. Only one mode can be active at any given times. "Enable the QPI (38H)" and "Disable the QPI (FFH)" commands are used to switch between these two modes. Upon power-up and after software reset using ""Reset (99H)" command, the default state of the device is Standard/Dual/Quad SPI mode. The QPI mode requires the non-volatile Quad Enable bit (QE) in Status Register to be set.

Hold

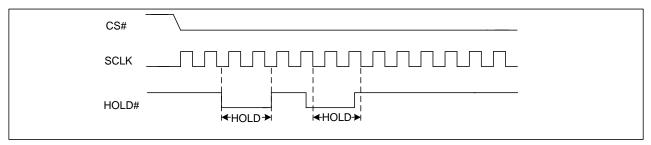
The HOLD# signal goes low to stop any serial communications with the device, but doesn't stop the operation of write status register, programming, or erasing in progress.

The operation of HOLD, need CS# keep low, and starts on falling edge of the HOLD# signal, with SCLK signal being low (if SCLK is not being low, HOLD operation will not start until SCLK being low). The HOLD condition ends on rising edge of HOLD# signal with SCLK being low (If SCLK is not being low, HOLD operation will not end until SCLK being low).

The SO is high impedance, both SI and SCLK don't care during the HOLD operation, if CS# drives high during HOLD operation, it will reset the internal logic of the device. To re-start communication with chip, the HOLD# must be at high and then CS# must be at low.



Figure1. Hold Condition



5. DATA PROTECTION

The FT25H64 provide the following data protection methods:

- Write Enable (WREN) command: The WREN command is set the Write Enable Latch bit (WEL). The WEL bit will return to reset by the following situation:
 - Power-Up
 - Write Disable (WRDI)
 - Write Status Register (WRSR)
 - Page Program (PP)
 - Sector Erase (SE) / Block Erase (BE) / Chip Erase (CE)
- Software Protection Mode: The Block Protect (BP4, BP3, BP2, BP1, BP0) bits define the section of the memory array that can be read but not change.
- Hardware Protection Mode: WP# going low to protected the BP0~BP4 bits and SRP bit.
- Deep Power-Down Mode: In Deep Power-Down Mode, all commands are ignored except the Release from Deep Power-Down Mode command.

s	tatus R	egister	Conte	nt	Memory Content					
BP4	BP3	BP2	BP1	BP0	Blocks	Addresses	Density	Portion		
Х	Х	0	0	0	NONE	NONE	NONE	NONE		
0	0	0	0	1	126 to 127	7E0000H-7FFFFFH	128KB	Upper 1/64		
0	0	0	1	0	124 to 127	7C0000H-7FFFFFH	256KB	Upper 1/32		
0	0	0	1	1	120 to 127	780000H-7FFFFFH	512KB	Upper 1/16		
0	0	1	0	0	112 to 127	700000H-7FFFFH	1MB	Upper 1/8		
0	0	1	0	1	96 to 127	600000H-7FFFFFH	2MB	Upper 1/4		
0	0	1	1	0	64 to 127	400000H-7FFFFFH	4MB	Upper 1/2		
0	1	0	0	1	0 to 1	000000H-01FFFFH	128KB	Lower 1/64		
0	1	0	1	0	0 to 3	000000H-03FFFFH	256KB	Lower 1/32		
0	1	0	1	1	0 to 7	000000H-07FFFFH	512KB	Lower 1/16		
0	1	1	0	0	0 to 15	000000H-0FFFFH	1MB	Lower 1/8		
0	1	1	0	1	0 to 31	000000H-1FFFFFH	2MB	Lower 1/4		
0	1	1	1	0	0 to 63	000000H-3FFFFFH	4MB	Lower 1/2		
Х	Х	1	1	1	0 to 127	000000H-7FFFFFH	8MB	ALL		
1	0	0	0	1	127	7FF000H-7FFFFFH	4KB	Top Block		
1	0	0	1	0	127	7FE000H-7FFFFFH	8KB	Top Block		
1	0	0	1	1	127	7FC000H-7FFFFFH	16KB	Top Block		
1	0	1	0	Х	127	7F8000H-7FFFFFH	32KB	Top Block		
1	0	1	1	0	127	7F8000H-7FFFFFH	32KB	Top Block		
1	1	0	0	1	0	000000H-000FFFH	4KB	Bottom Block		
1	1	0	1	0	0	000000H-001FFFH	8KB	Bottom Block		
1	1	0	1	1	0	000000H-003FFFH	16KB	Bottom Block		
1	1	1	0	Х	0	000000H-007FFFH	32KB	Bottom Block		
1	1	1	1	0	0	000000H-007FFFH	32KB	Bottom Block		

Table1.0 FT25H64 Protected area size (CMP=0)



S	tatus R	egister	Conte	nt		Memory Content						
BP4 BP3 BP2 BP1 BP0			BP0	Blocks	Addresses	Density	Portion					
Х	Х	0	0	0	ALL	000000H-7FFFFFH	ALL	ALL				
0	0	0	0	1	0 to 125	000000H-7DFFFFH	8064KB	Lower 63/64				
0	0	0	1	0	0 to 123	000000H-7BFFFFH	7936KB	Lower 31/32				
0	0	0	1	1	0 to 119	000000H-77FFFFH	7680KB	Lower 15/16				
0	0	1	0	0	0 to 111	000000H-6FFFFH	7MB	Lower 7/8				
0	0	1	0	1	0 to 95	000000H-5FFFFH	6MB	Lower 3/4				
0	0	1	1	0	0 to 63	000000H-4FFFFFH	4MB	Lower 1/2				
0	1	0	0	1	2 to 127	020000H-7FFFFFH	8064KB	Upper 63/64				
0	1	0	1	0	4 to127	040000H-7FFFFFH	7936KB	Upper 31/32				
0	1	0	1	1	8 to 127	080000H-7FFFFFH	7680KB	Upper 15/16				
0	1	1	0	0	16 to 127	100000H-7FFFFFH	7MB	Upper 7/8				
0	1	1	0	1	32 to 127	200000H-7FFFFFH	6MB	Upper 3/4				
0	1	1	1	0	64 to 127	400000H-7FFFFFH	4MB	Upper 1/2				
Х	Х	1	1	1	NONE	NONE	NONE	NONE				
1	0	0	0	1	0 to 127	000000H-7FEFFFH	8188KB	L-2047/2048				
1	0	0	1	0	0 to 127	000000H-7FDFFFH	8184KB	L-1023/1024				
1	0	0	1	1	0 to 127	000000H-7FBFFFH	8176KB	L-511/512				
1	0	1	0	Х	0 to 127	000000H-7F7FFFH	8160KB	L-255/256				
1	0	1	1	0	0 to 127	000000H-7F7FFFH	8160KB	L-255/256				
1	1	0	0	1	0 to 127	001000H-7FFFFFH	8188KB	U-2047/2048				
1	1	0	1	0	0 to 127	002000H-7FFFFFH	8184KB	U-1023/1024				
1	1	0	1	1	0 to 127	004000H-7FFFFFH	8176KB	U-511/512				
1	1	1	0	Х	0 to 127	008000H-7FFFFH	8160KB	U-255/256				
1	1	1	1	0	0 to 127	008000H-7FFFFFH	8160KB	U-255/256				



WIP

WEL

BP0

6. STATUS REGISTER

BP4

S15	S14	S13	S12	S11	S10	S9	S8
SUS	CMP	Reserved	Reserved	Reserved	LB	QE	SRP1
S 7	S 6	S5	S4	S3	S2	S1	S0

BP2

BP1

The status and control bits of the Status Register are as follows:

BP3

WIP bit.

SRP0

The Write In Progress (WIP) bit indicates whether the memory is busy in program/erase/write status register progress. When WIP bit sets to 1, means the device is busy in program/erase/write status register progress, when WIP bit sets 0, means the device is not in program/erase/write status register progress.

WEL bit.

The Write Enable Latch (WEL) bit indicates the status of the internal Write Enable Latch. When set to 1 the internal Write Enable Latch is set, when set to 0 the internal Write Enable Latch is reset and no Write Status Register, Program or Erase command is accepted.

BP4, BP3, BP2, BP1, BP0 bits.

The Block Protect (BP4, BP3, BP2, BP1, BP0) bits are non-volatile. They define the size of the area to be software protected against Program and Erase commands. These bits are written with the Write Status Register (WRSR) command. When the Block Protect (BP4, BP3, BP2, BP1, BP0) bits are set to 1, the relevant memory area (as defined in Table1) becomes protected against Page Program (PP), Sector Erase (SE) and Block Erase (BE) commands. The Block Protect (BP4, BP3, BP2, BP1, BP0) bits can be written provided that the Hardware Protected mode has not been set. The Chip Erase (CE) command is executed if the Block Protect (BP2, BP1, BP0) bits are 0 and CMP=0 or the Block Protect (BP2, BP1, BP0) bits are 1 and CMP=1.

SRP1, SRP0 bits.

The Status Register Protect (SRP1 and SRP0) bits are non-volatile Read/Write bits in the status register. The SRP bits control the method of write protection: software protection, hardware protection, power supply lock-down or one-time programmable protection.



SRP1	SRP0	WP#	Status Register Description				
0	0	х	Software Protected	The Status Register can be written to after a Write			
0	0	^	Soliware Fiolecleu	Enable command, WEL=1. (Default)			
0	1	0	Hardware Protected	WP#=0, the Status Register locked and can not be			
0	I	0	Haluwale Flolecleu	written until the next power-up.			
0	1	1	Hardware	WP#=1, the Status Register is unlocked and can be			
0	I	1	Unprotected	written to after a Write Enable command, WEL=1.			
1	0	v	Power Supply	Status Register is protected and cannot be written to			
	0	X	Lock-Down ⁽¹⁾⁽²⁾	again until the next Power-Down, Power-Up cycle.			
1	1	х	One-Time Program ⁽²⁾	Status Register is permanently protected and cannot be			
	I	~	One-Time Program	written to.			

NOTE:

1. When SRP1, SRP0= (1, 0), a Power-Down, Power-Up cycle will change SRP1, SRP0 to (0, 0) state.

2. This feature is available on special order (FT25H64xxSx). Please contact XTX for details.

QE bit.

The Quad Enable (QE) bit is a non-volatile Read/Write bit in the Status Register that allows Quad operation. When the QE bit is set to 0 (Default) the WP# pin and HOLD# pin are enable. When the QE pin is set to 1, the Quad IO2 and IO3 pins are enabled. (The QE bit should never be set to 1 during standard SPI or Dual SPI operation if the WP# or HOLD# pins are tied directly to the power supply or ground).

LB bit.

The LB bit is a non-volatile One Time Program (OTP) bit in Status Register (S10) that provide the write protect control and status to the Security Registers. The default state of LB is 0, the security registers are unlocked. LB can be set to 1 individually using the Write Register instruction. LB is One Time Programmable, once it's set to 1, the Security Registers will become read-only permanently.

CMP bit.

The CMP bit is a non-volatile Read/Write bit in the Status Register (S14). It is used in conjunction the BP4-BP0 bits to provide more flexibility for the array protection. Please see the Status register Memory Protection table for details. The default setting is CMP=0.

SUS bit.

The SUS bit is a read only bit in the status register (S15) that is set to 1 after executing an Erase/Program Suspend (75H or B0H) command. The SUS bit is cleared to 0 by Erase/Program Resume (7AH or 30H) command as well as a power-down, power-up cycle.



7. COMMANDS DESCRIPTION

All commands, addresses and data are shifted in and out of the device, beginning with the most significant bit on the first rising edge of SCLK after CS# is driven low. Then, the one-byte command code must be shifted in to the device, most significant bit first on SI, each bit being latched on the rising edges of SCLK.

See Table2, every command sequence starts with a one-byte command code. Depending on the command, this might be followed by address bytes, or by data bytes, or by both or none. CS# must be driven high after the last bit of the command sequence has been shifted in. For the command of Read, Fast Read, Read Status Register or Release from Deep Power-Down, and Read Device ID, the shifted-in command sequence is followed by a data-out sequence. CS# can be driven high after any bit of the data-out sequence is being shifted out.

For the command of Page Program, Sector Erase, Block Erase, Chip Erase, Write Status Register, Write Enable, Write Disable or Deep Power-Down command, CS# must be driven high exactly at a byte boundary, otherwise the command is rejected, and is not executed. That is CS# must driven high when the number of clock pulses after CS# being driven low is an exact multiple of eight. For Page Program, if at any time the input byte is not a full byte, nothing will happen and WEL will not be reset.

Command Name	Byte1	Byte2	Byte3	Byte4	Byte5	Byte6	n-Bytes
Write Enable	06H						
Write Enable for Volatile	50H						
Status Register	501						
Write Disable	04H						
Read Status Register	05H	(S7-S0)					(continuous)
Read Status Register-1	35H	(S15-S8)					(continuous)
Write Status Register	01H	(S7-S0)	(S15-S8)				(continuous)
Read Data	03H	A23-A16	A15-A8	A7-A0	(D7-D0)	(Next byte)	(continuous)
Fast Read	0BH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	(continuous)
Dual Output Fast Read	3BH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0) ⁽¹⁾	(continuous)
Dual I/O Fast Read	ввн	A23-A8 ⁽²⁾	A7-A0	(D7-D0) ⁽¹⁾			(continuous)
Buarrio Fast field			M7-M0 ⁽²⁾	(87 80)			(00/11/10003)
Quad Output Fast Read	6BH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0) ⁽³⁾	(continuous)
Quad I/O Fast Read	EBH	A23-A0	dummy ⁽⁵⁾	(D7-D0) ⁽³⁾			(continuous)
		M7-M0 ⁽⁴⁾		(07-00)			(continuous)
Quad I/O Word Fast	E7H	A23-A0	dummy ⁽⁶⁾	(D7-D0) ⁽³⁾			(continuous)
Read	2/11	M7-M0 ⁽⁴⁾	danniny	(87 80)			(00111110000)
Continuous Read Reset	FFH						
Page Program	02H	A23-A16	A15-A8	A7-A0	(D7-D0)	(Next byte)	
Quad Page Program	32H	A23-A16	A15-A8	A7-A0	(D7-D0) ⁽³⁾		
Sector Erase	20H	A23-A16	A15-A8	A7-A0			
Block Erase(32KB)	52H	A23-A16	A15-A8	A7-A0			
Block Erase(64KB)	D8H	A23-A16	A15-A8	A7-A0			

Table2. Commands



Command Name	Byte1	Byte2	Byte3	Byte4	Byte5	Byte6	n-Bytes
Chip Erase	C7/60H						
Enable QPI	38H						
Set Burst with Wrap	77H	dummy	dummy	dummy	W6-W4		
Program/Erase suspend	75/B0H						
Program/Erase Resume	7A/30H						
Deep Power-Down	B9H						
Release From Deep Power-Down, And Read Device ID	ABH	dummy	dummy	dummy	(ID7-DID0)		(continuous)
Release From Deep Power-Down	ABH						
Manufacturer/Device ID	90H	dummy	dummy	00H	(M7-M0)	(ID7-ID0)	(continuous)
Manufacturer/Device ID by Dual I/O	92H	A23-A8	A7-A0, M[7:0]	(M7-M0) (ID7-ID0)			(continuous)
Manufacturer/Device ID by Quad I/O	94H	A23-A0, M[7:0]	dummy	(M7-M0) (ID7-ID0)			
Read Serial Flash Discoverable Parameters	5AH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	(continuous)
Read Identification	9FH	(M7-M0)	(ID15-ID8)	(ID7-ID0)			(continuous)
Erase Security Register ⁽⁸⁾	44H	A23-A16	A15-A8	A7-A0			
Program Security Register ⁽⁸⁾	42H	A23-A16	A15-A8	A7-A0	(D7-D0)	(Next byte)	
Read Security Register ⁽⁸⁾	48H	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	
Enable Reset	66H						
Reset	99H						



Table2a. Commands (QPI)

Command Name	Byte1	Byte2	Byte3	Byte4	Byte5	Byte6
Clock Number	(0,1)	(2,3)	(4,5)	(6,7)	(8,9)	(10,11)
Write Enable	06H					
Write Enable for Volatile Status Register	50H					
Write Disable	04H					
Read Status Register	05H	(S7-S0)				
Read Status Register-1	35H	(S15-S8)				
Write Status Register	01H	(S7-S0)	(S15-S8)			
Page Program	02H	A23-A16	A15-A8	A7-A0	(D7-D0)	(Next byte)
Sector Erase	20H	A23-A16	A15-A8	A7-A0		
Block Erase(32KB)	52H	A23-A16	A15-A8	A7-A0		
Block Erase(64KB)	D8H	A23-A16	A15-A8	A7-A0		
Chip Erase	C7/60H					
Program/Erase suspend	75/B0H					
Program/Erase Resume	7A/30H					
Deep Power-Down	B9H					
Set Read Parameters	СОН	P7-P0				
Fast Read	0BH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)
Burst Read with Wrap	0CH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)
Quad I/O Fast Read	EBH	A23-A0	dummy ⁽⁵⁾	(D7-D0) ⁽³⁾		
Release from Deep Power-Down, And Read Device ID ⁽¹⁰⁾	ABH	dummy	dummy	dummy * N	(ID7-ID0)	
Manufacturer/Device ID ⁽¹¹⁾	90H	dummyx2	00H	dummy * N	MID7~MID0	(ID7-ID0)
Disable QPI	FFH					
Enable Reset	66H					
Reset	99H					

NOTE:

1. Dual Output data

IO0 = (D6, D4, D2, D0)

IO1 = (D7, D5, D3, D1)

2. Dual Input Address

IO0 = A22, A20, A18, A16, A14, A12, A10, A8,A6, A4, A2, A0, M6, M4, M2, M0 IO1 = A23, A21, A19, A17, A15, A13, A11, A9,A7, A5, A3, A1, M7, M5, M3, M1

3. Quad Output Data

IO0 = (D4, D0,) IO1 = (D5, D1,) IO2 = (D6, D2,) IO3 = (D7, D3,)



4. Quad Input Address

IO0 = A20, A16, A12, A8, A4, A0, M4, M0 IO1 = A21, A17, A13, A9, A5, A1, M5, M1 IO2 = A22, A18, A14, A10, A6, A2, M6, M2 IO3 = A23, A19, A15, A11, A7, A3, M7, M3

5. Quad I/O Fast Read Data

IO0 = (x, x, x, x, D4, D0,...) IO1 = (x, x, x, x, D5, D1,...) IO2 = (x, x, x, x, D6, D2,...) IO3 = (x, x, x, x, D7, D3,...)

6. Quad I/O Word Fast Read Data

IO0 = (x, x, D4, D0,...) IO1 = (x, x, D5, D1,...)

IO2 = (x, x, D6, D2,...)

IO3 = (x, x, D7, D3,...)

7. Quad I/O Word Fast Read Data: the lowest address bit must be 0.

8. Security Registers Address:

Security Register0: A23-A16=00H, A15-A8=00H, A7-A0= Byte Address; Security Register1: A23-A16=00H, A15-A8=01H, A7-A0= Byte Address; Security Register2: A23-A16=00H, A15-A8=02H, A7-A0= Byte Address; Security Register3: A23-A16=00H, A15-A8=03H, A7-A0= Byte Address.

9. QPI Command, Address, Data input/output format:

CLK# 0 1	2 3	4 5	67	89	10 11
IO0 = C4, C0,	A20, A16,	A12, A8,	A4, A0,	D4, D0,	D4, D0
IO1 = C5, C1,	A21, A17,	A13, A9,	A5, A1,	D5, D1,	D5, D1
IO2 = C6, C2,	A22, A18,	A14, A10,	A6, A2,	D6, D2,	D6, D2
IO3 = C7, C3,	A23, A19,	A15, A11,	A7, A3,	D7, D3,	D7, D4

10. QPI mode: Release from Deep Power-Down, And Read Device ID (ABH)

N dummy cycles should be inserted before ID read cycle, refer to C0H command 11. QPI mode: Manufacturer/Device ID (90H)

N dummy cycles should be inserted before ID read cycle, refer to C0H command

Table of ID Definitions:

Operation Code	M7-M0	ID15-ID8	ID7-ID0
9FH	0E	40	17
90H	0E		16
ABH			16

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7.1. Write Enable (WREN) (06H)

The Write Enable (WREN) command is for setting the Write Enable Latch (WEL) bit. The Write Enable Latch (WEL) bit must be set prior to every Page Program (PP), Sector Erase (SE), Block Erase (BE), Chip Erase (CE) and Write Status Register (WRSR) command. The Write Enable (WREN) command sequence: CS# goes low→Sending the Write Enable command→CS# goes high.

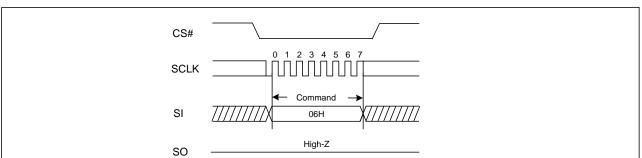
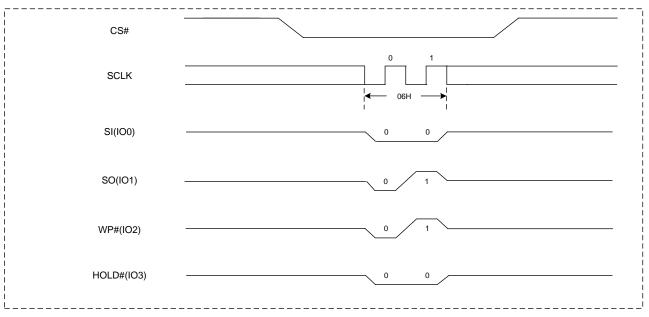


Figure 2. Write Enable Sequence Diagram

Figure 2a. Write Enable Sequence Diagram (QPI)



7.2. Write Enable for Volatile Status Register (50H)

The non-volatile Status Register bits can also be written to as volatile bits. This gives more flexibility to change the system configuration and memory protection schemes quickly without waiting for the typical non-volatile bit write cycles or affecting the endurance of the Status Register non-volatile bits. The Write Enable for Volatile Status Register command must be issued prior to a Write Status Register command and any other commands can't be inserted between them. Otherwise, Write Enable for Volatile Status Register will be cleared. The Write Enable for Volatile Status Register command to change the volatile Status Register bit values.



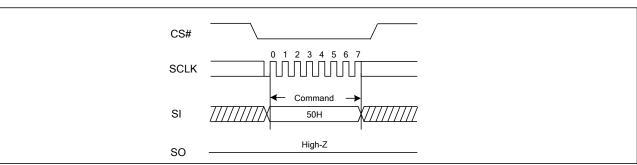
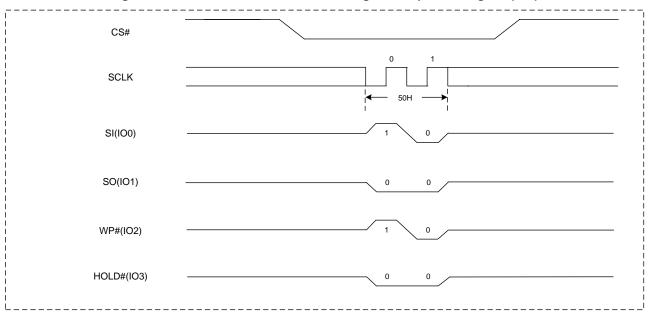


Figure 3. Write Enable for Volatile Status Register Sequence Diagram

Figure3a. Write Enable for Volatile Status Register Sequence Diagram (QPI)

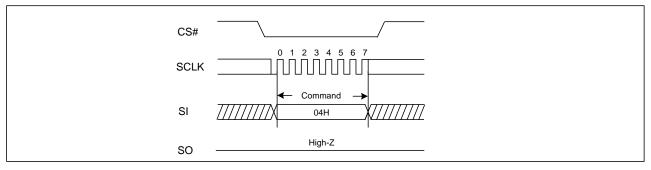


7.3. Write Disable (WRDI) (04H)

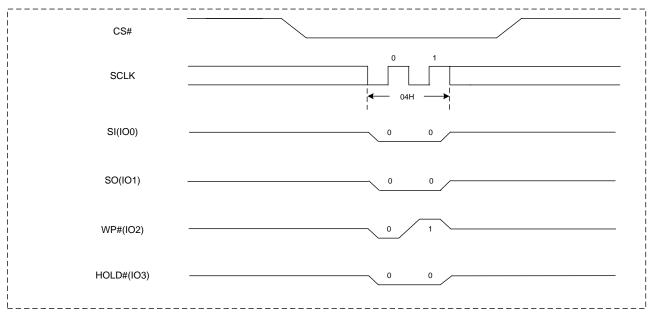
The Write Disable command is for resetting the Write Enable Latch (WEL) bit. The Write Disable command sequence: CS# goes low \rightarrow Sending the Write Disable command \rightarrow CS# goes high. The WEL bit is reset by following condition: Power-up and upon completion of the Write Status Register, Page Program, Sector Erase, Block Erase and Chip Erase commands.









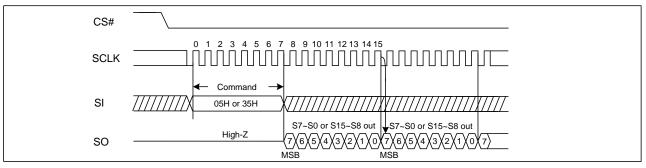


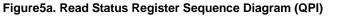
7.4. Read Status Register (RDSR) (05H or 35H)

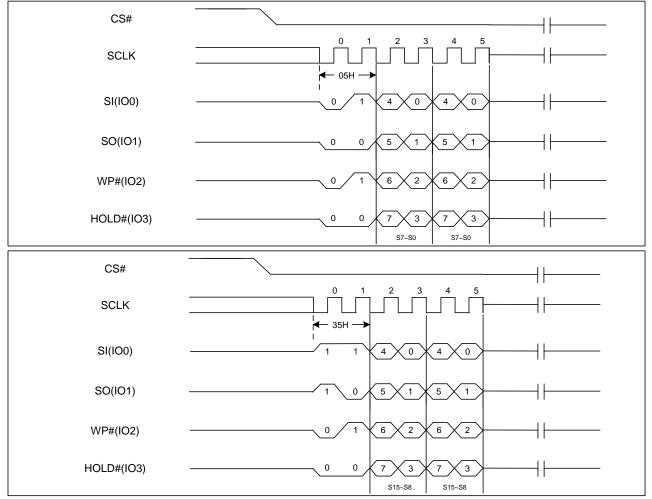
The Read Status Register (RDSR) command is for reading the Status Register. The Status Register may be read at any time, even while a Program, Erase or Write Status Register cycle is in progress. When one of these cycles is in progress, it is recommended to check the Write In Progress (WIP) bit before sending a new command to the device. It is also possible to read the Status Register continuously. For command code "05H", the SO will output Status Register bits S7~S0. The command code "35H", the SO will output Status Register bits S15~S8.











7.5. Write Status Register (WRSR) (01H)

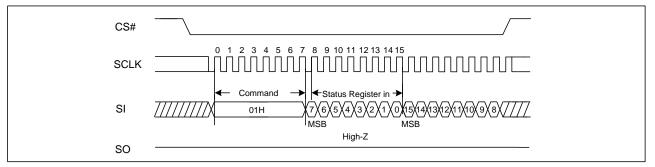
The Write Status Register (WRSR) command allows new values to be written to the Status Register. Before it can be accepted, a Write Enable (WREN) command must previously have been executed. After the Write Enable (WREN) command has been decoded and executed, the device sets the Write Enable Latch (WEL).

The Write Status Register (WRSR) command has no effect on S15, S13, S12, S11, S1 and S0 of the Status Register. CS# must be driven high after the eighth or sixteen bit of the data byte has been latched in. If not, the Write Status Register (WRSR) command is not executed. If CS# is driven high after eighth bit of the



data byte, the CMP and QE bit will be cleared to 0. As soon as CS# is driven high, the self-timed Write Status Register cycle (whose duration is t_W) is initiated. While the Write Status Register cycle is in progress, the Status Register may still be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Write Status Register cycle, and is 0 when it is completed. When the cycle is completed, the Write Enable Latch (WEL) is reset.

The Write Status Register (WRSR) command allows the user to change the values of the Block Protect (BP4, BP3, BP2, BP1, BP0) bits, to define the size of the area that is to be treated as read-only, as defined in Table1. The Write Status Register (WRSR) command also allows the user to set or reset the Status Register Protect (SRP) bit in accordance with the Write Protect (WP#) signal. The Status Register Protect (SRP) bit and Write Protect (WP#) signal allow the device to be put in the Hardware Protected Mode. The Write Status Register (WRSR) command is not executed once the Hardware Protected Mode is entered.





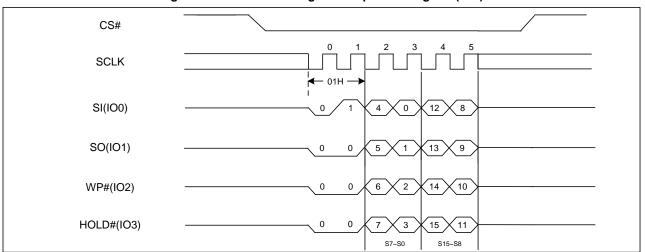
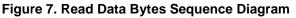


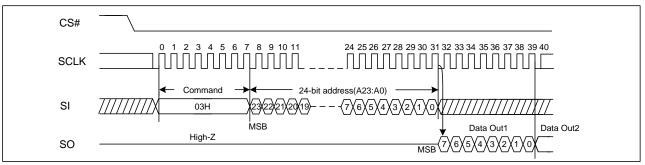
Figure 6a. Write Status Register Sequence Diagram (QPI)

7.6. Read Data Bytes (READ) (03H)

The Read Data Bytes (READ) command is followed by a 3-byte address (A23-A0), each bit being latched-in during the rising edge of SCLK. Then the memory content, at that address, is shifted out on SO, each bit being shifted out, at a Max frequency f_R , during the falling edge of SCLK. The first byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out. The whole memory can, therefore, be read with a single Read Data Bytes (READ) command. Any Read Data Bytes (READ) command, while an Erase, Program or Write cycle is in progress, is rejected without having any effects on the cycle that is in progress.







7.7. Read Data Bytes At Higher Speed (Fast Read) (0BH)

The Read Data Bytes at Higher Speed (Fast Read) command is for quickly reading data out. It is followed by a 3-byte address (A23-A0) and a dummy byte, each bit being latched-in during the rising edge of SCLK. Then the memory content, at that address, is shifted out on SO, each bit being shifted out, at a Max frequency f_c , during the falling edge of SCLK. The first byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out.

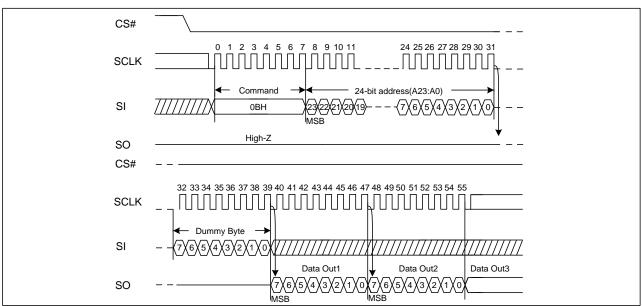


Figure 8. Read Data Bytes at Higher Speed Sequence Diagram

Fast Read (0BH) in QPI mode

The Fast Read command is also supported in QPI mode. In QPI mode, the number of dummy clocks is configured by the "Set Read Parameters (C0H)" command to accommodate a wide range application with different needs for either maximum Fast Read frequency or minimum data access latency. Depending on the Read Parameter Bits P[5:4] setting, the number of dummy clocks can be configured as either 4/6/8. When the dummy cycle is configured to 4, addr [0] input must be 0.



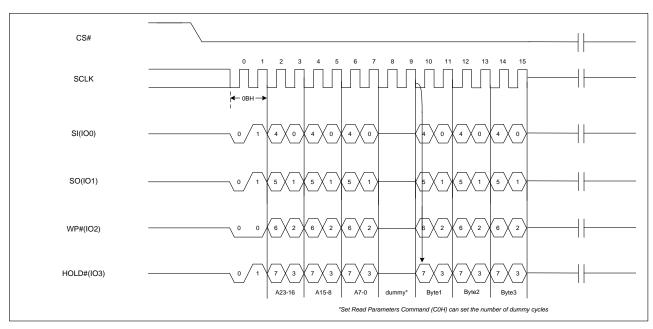
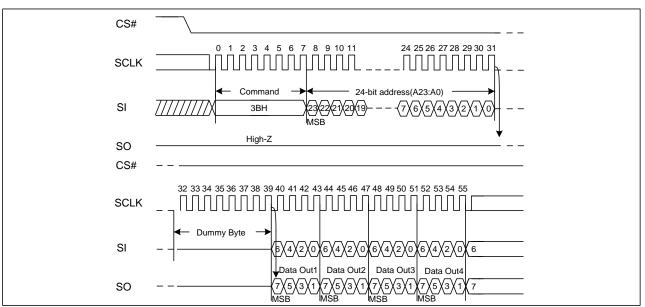


Figure 8a. Read Data Bytes at Higher Speed Sequence Diagram (QPI)

7.8. Dual Output Fast Read (3BH)

The Dual Output Fast Read command is followed by 3-byte address (A23-A0) and a dummy byte, each bit being latched in during the rising edge of SCLK, then the memory contents are shifted out 2-bit per clock cycle from SI and SO. The command sequence is shown in followed Figure9. The first byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out.



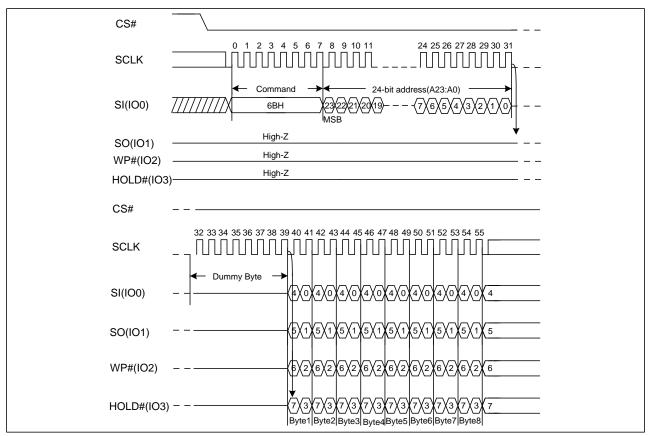


7.9. Quad Output Fast Read (6BH)

The Quad Output Fast Read command is followed by 3-byte address (A23-A0) and a dummy byte, each bit being latched in during the rising edge of SCLK, then the memory contents are shifted out 4-bit per clock



cycle from IO3, IO2, IO1 and IO0. The command sequence is shown in followed Figure10. The first byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out.





7.10. Dual I/O Fast Read (BBH)

The Dual I/O Fast Read command is similar to the Dual Output Fast Read command but with the capability to input the 3-byte address (A23-0) and a "Continuous Read Mode" byte 2-bit per clock by SI and SO, each bit being latched in during the rising edge of SCLK, then the memory contents are shifted out 2-bit per clock cycle from SI and SO. The command sequence is shown in followed Figure11. The first byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out.

Dual I/O Fast Read with "Continuous Read Mode"

The Dual I/O Fast Read command can further reduce command overhead through setting the "Continuous Read Mode" bits (M7- 0) after the input 3-byte address (A23-A0). If the "Continuous Read Mode" bits (M5- 4) =(1, 0), then the next Dual I/O Fast Read command (after CS# is raised and then lowered) does not require the BBH command code. The command sequence is shown in followed Figure 12. If the "Continuous Read Mode" bits (M5- 4) do not equal (1, 0), the next command requires the first BBH command code, thus returning to normal operation. A "Continuous Read Mode" Reset command can be used to reset (M5- 4) before issuing normal command.



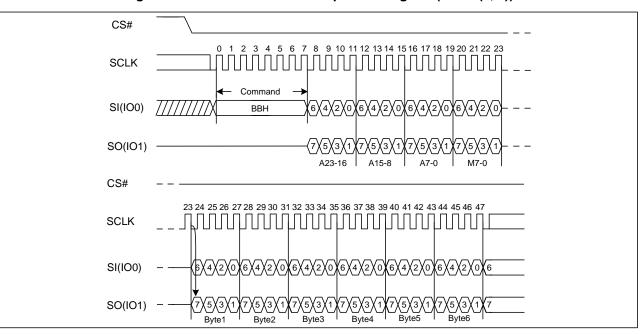
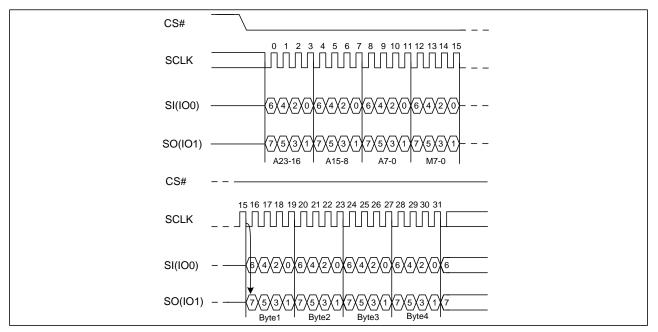


Figure 11. Dual I/O Fast Read Sequence Diagram (M5-4≠(1, 0))





7.11. Quad I/O Fast Read (EBH)

The Quad I/O Fast Read command is similar to the Dual I/O Fast Read command but with the capability to input the 3-byte address (A23-0) and a "Continuous Read Mode" byte and 4-dummy clock 4-bit per clock by IO0, IO1, IO3, IO4, each bit being latched in during the rising edge of SCLK, then the memory contents are shifted out 4-bit per clock cycle from IO0, IO1, IO2, IO3. The command sequence is shown in followed Figure 13. The first byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out. The Quad Enable bit (QE) of Status Register (S9) must be set to enable for the Quad I/O Fast read command.



Quad I/O Fast Read with "Continuous Read Mode"

The Quad I/O Fast Read command can further reduce command overhead through setting the "Continuous Read Mode" bits (M7-0) after the input 3-byte address (A23-A0). If the "Continuous Read Mode" bits (M5- 4) =(1, 0), then the next Quad I/O Fast Read command (after CS# is raised and then lowered) does not require the EBH command code. The command sequence is shown in followed Figure 14. If the "Continuous Read Mode" (M5- 4) do not equal (1, 0), the next command requires the first EBH command code, thus returning to normal operation. A "Continuous Read Mode" Reset command can be used to reset (M5- 4) before issuing normal command.

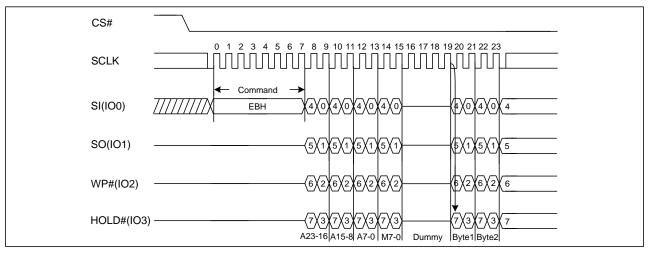
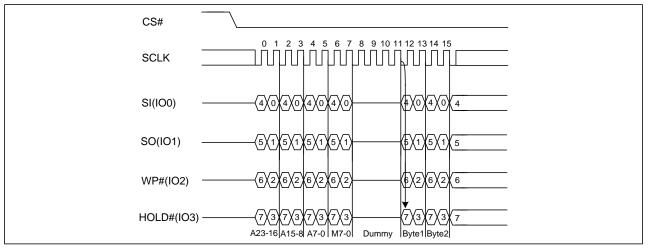


Figure 13. Quad I/O Fast Read Sequence Diagram (M5-4≠(1, 0))





Quad I/O Fast Read with "8/16/32/64-Byte Wrap Around" in Standard SPI mode

The Quad I/O Fast Read command can be used to access a specific portion within a page by issuing "Set Burst with Wrap" (77H) commands prior to EBH. The "Set Burst with Wrap" (77H) command can either enable or disable the "Wrap Around" feature for the following EBH commands. When "Wrap Around" is enabled, the data being accessed can be limited to either an 8/16/32/64-byte section of a 256-byte page. The output data starts at the initial address specified in the command, once it reaches the ending boundary of the 8/16/32/64-byte section, the output will wrap around the beginning boundary automatically until CS# is pulled high to terminate the command.

The Burst with Wrap feature allows applications that use cache to quickly fetch a critical address and then fill



the cache afterwards within a fixed length (8/16/32/64-byte) of data without issuing multiple read commands. The "Set Burst with Wrap" command allows three "Wrap Bits" W6-W4 to be set. The W4 bit is used to enable or disable the "Wrap Around" operation while W6-W5 is used to specify the length of the wrap around section within a page.

Quad I/O Fast Read (EBH) in QPI mode

The Quad I/O Fast Read command is also supported in QPI mode. See Figure12b. In QPI mode, the number of dummy clocks is configured by the "Set Read Parameters (C0H)" command to accommodate a wide range application with different needs for either maximum Fast Read frequency or minimum data access latency. Depending on the Read Parameter Bits P[5:4] setting, the number of dummy clocks can be configured as either 4/6/8. When the dummy cycle is configured to 4, addr[0] input must be 0. In QPI mode, the "Continuous Read Mode" bits M7-M0 are also considered as dummy clocks. "Continuous Read Mode" feature is also available in QPI mode for Quad I/O Fast Read command. "Wrap Around" feature is not available in QPI mode for Quad I/O Fast Read command. To perform a read operation with fixed data length wrap around in QPI mode, a dedicated "Burst Read with Wrap" (0CH) command must be used.

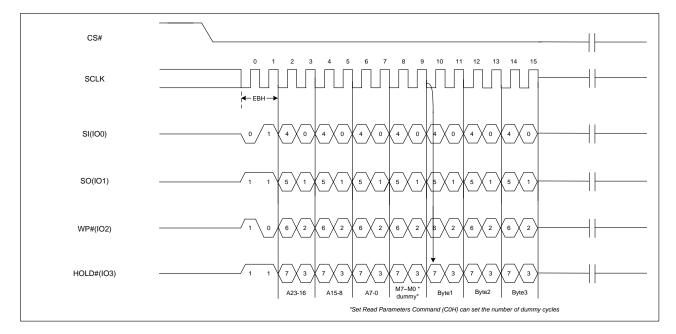


Figure14b. Quad I/O Fast Read Sequence Diagram (M5-4= (1, 0) QPI)

7.12. Quad I/O Word Fast Read (E7H)

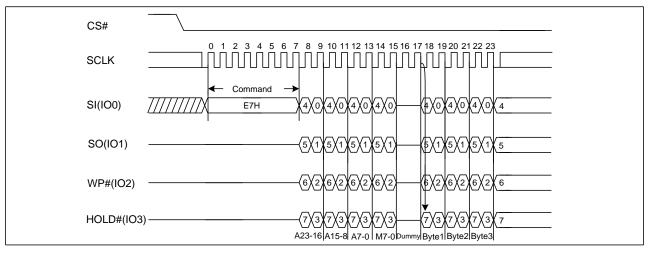
The Quad I/O Word Fast Read command is similar to the Quad I/O Fast Read command except that the lowest address bit (A0) must equal 0 and only 2-dummy clock. The command sequence is shown in followed Figure 15. The first byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out. The Quad Enable bit (QE) of Status Register (S9) must be set to enable for the Quad I/O Word Fast read command.

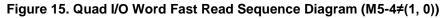
Quad I/O Word Fast Read with "Continuous Read Mode"

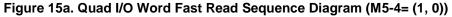
The Quad I/O Word Fast Read command can further reduce command overhead through setting the "Continuous Read Mode" bits (M7-0) after the input 3-byte address (A23-A0). If the "Continuous Read Mode" bits (M5- 4) =(1, 0), then the next Quad I/O Word Fast Read command (after CS# is raised and then lowered)

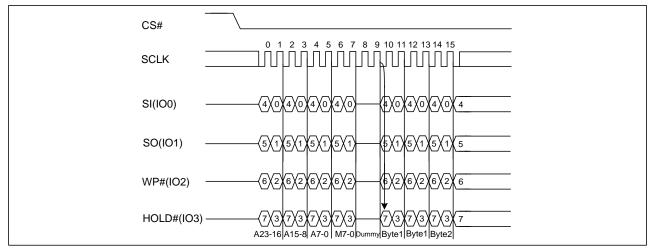


does not require the E7H command code. The command sequence is shown in followed Figure15.1. If the "Continuous Read Mode" bits (M5- 4) do not equal (1, 0), the next command requires the first E7H command code, thus returning to normal operation. A "Continuous Read Mode" Reset command can be used to reset (M7-0) before issuing normal command.









Quad I/O Word Fast Read with "8/16/32/64-Byte Wrap Around" in Standard SPI mode

The Quad I/O Word Fast Read command can be used to access a specific portion within a page by issuing "Set Burst with Wrap" (77H) commands prior to E7H. The "Set Burst with Wrap" (77H) command can either enable or disable the "Wrap Around" feature for the following E7H commands. When "Wrap Around" is enabled, the data being accessed can be limited to either an 8/16/32/64-byte section of a 256-byte page. The output data starts at the initial address specified in the command, once it reaches the ending boundary of the 8/16/32/64-byte section, the output will wrap around the beginning boundary automatically until CS# is pulled high to terminate the command. The Burst with Wrap feature allows applications that use cache to quickly fetch a critical address and then fill the cache afterwards within a fixed length (8/16/32/64-byte) of data without issuing multiple read commands. The "Set Burst with Wrap" command allows three "Wrap Bits" W6-W4 to be set. The W4 bit is used to enable or disable the "Wrap Around" operation while W6-W5 is used to specify the length of the wrap around section within a page.



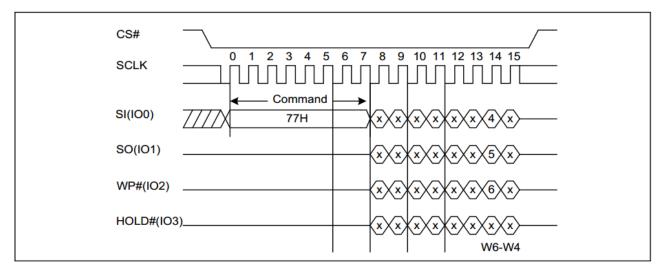
7.13. Set Burst with Wrap (77H)

The Set Burst with Wrap command is used in conjunction with "Quad I/O Fast Read" and "Quad I/O Word Fast Read" command to access a fixed length of 8/16/32/64-byte section within a 256-byte page, in standard SPI mode. The Set Burst with Wrap command sequence: CS# goes low \rightarrow Send Set Burst with Wrap command \rightarrow Send 24 dummy bits \rightarrow Send 8 bits "Wrap bits" \rightarrow CS# goes high

W6,W5 Wrap Around	W	1=0	W4=1 (default)		
	Wrap Length	Wrap Around	Wrap Length		
0, 0	Yes	8-byte	No	N/A	
0, 1	Yes	16-byte	No	N/A	
1, 0	Yes	32-byte	No	N/A	
1, 1	Yes	64-byte	No	N/A	

If the W6-W4 bits are set by the Set Burst with Wrap command, all the following "Quad I/O Fast Read" and "Quad I/O Word Fast Read" command will use the W6-W4 setting to access the 8/16/32/64-byte section within any page. To exit the "Wrap Around" function and return to normal read operation, another Set Burst with Wrap command should be issued to set W4=1. In QPI mode, the "Burst Read with Wrap (0CH)" command should be used to perform the Read Operation with "Wrap Around" feature. The Wrap Length set by W5-W6 in Standard SPI mode is still valid in QPI mode and can also be re-configured by "Set Read Parameters (C0H) command.





7.14. Page Program (PP) (02H)

The Page Program (PP) command is for programming the memory. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit before sending the Page Program command.

The Page Program (PP) command is entered by driving CS# Low, followed by the command code, three address bytes and at least one data byte on SI. If the 8 least significant address bits (A7-A0) are not all zero, all transmitted data that goes beyond the end of the current page are programmed from the start address of the same page (from the address whose 8 least significant bits (A7-A0) are all zero). CS# must be driven low for the entire duration of the sequence. The Page Program command sequence: CS# goes low→sending



Page Program command \rightarrow 3-byte address on SI \rightarrow at least 1 byte data on SI \rightarrow CS# goes high. The command sequence is shown in Figure 17. If more than 256 bytes are sent to the device, previously latched data are discarded and the last 256 data bytes are guaranteed to be programmed correctly within the same page. If less than 256 data bytes are sent to device, they are correctly programmed at the requested addresses without having any effects on the other bytes of the same page. CS# must be driven high after the eighth bit of the last data byte has been latched in; otherwise the Page Program (PP) command is not executed.

As soon as CS# is driven high, the self-timed Page Program cycle (whose duration is t_{PP}) is initiated. While the Page Program cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Page Program cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset.

A Page Program (PP) command applied to a page which is protected by the Block Protect (BP4, BP3, BP2, BP1, BP0) is not executed.

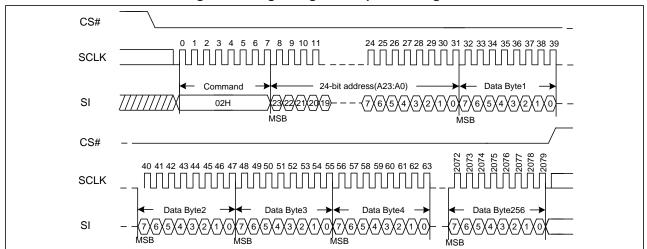
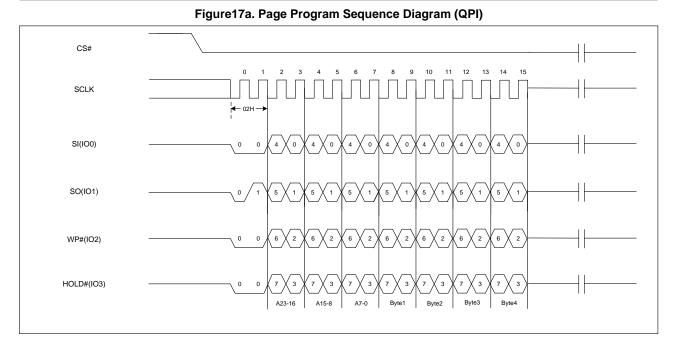


Figure 17. Page Program Sequence Diagram



7.15. Quad Page Program (QPP) (32H)

The Quad Page Program command is for programming the memory using four pins: IO0, IO1, IO2, and IO3. To use Quad Page Program the Quad enable in status register Bit9 must be set (QE=1). A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit before sending the Page Program command. The Quad Page Program command is entered by driving CS# Low, followed by the command code (32H), three address bytes and at least one data byte on IO pins.

The command sequence is shown in Figure18. If more than 256 bytes are sent to the device, previously latched data are discarded and the last 256 data bytes are guaranteed to be programmed correctly within the same page. If less than 256 data bytes are sent to device, they are correctly programmed at the requested addresses without having any effects on the other bytes of the same page. CS# must be driven high after the eighth bit of the last data byte has been latched in; otherwise the Quad Page Program command is not executed.

As soon as CS# is driven high, the self-timed Quad Page Program cycle (whose duration is t_{PP}) is initiated. While the Quad Page Program cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Quad Page Program cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset

A Quad Page Program command applied to a page which is protected by the Block Protect (BP4, BP3, BP2, BP1, BP0) is not executed.



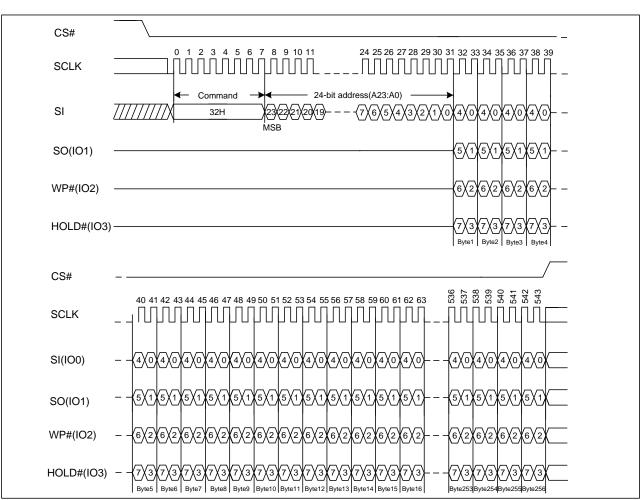


Figure 18. Quad Page Program Sequence Diagram

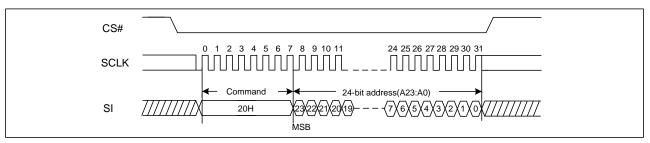
7.16. Sector Erase (SE) (20H)

The Sector Erase (SE) command is for erasing the all data of the chosen sector. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit. The Sector Erase (SE) command is entered by driving CS# low, followed by the command code, and 3-address byte on SI. Any address inside the sector is a valid address for the Sector Erase (SE) command. CS# must be driven low for the entire duration of the sequence.

The Sector Erase command sequence: CS# goes low \rightarrow sending Sector Erase command \rightarrow 3-byte address on SI \rightarrow CS# goes high. The command sequence is shown in Figure20. CS# must be driven high after the eighth bit of the last address byte has been latched in; otherwise the Sector Erase (SE) command is not executed. As soon as CS# is driven high, the self-timed Sector Erase cycle (whose duration is t_{SE}) is initiated. While the Sector Erase cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Sector Erase cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. A Sector Erase (SE) command applied to a sector which is protected by the Block Protect (BP4, BP3, BP2, BP1, BP0) bit (see Table1.0&1.1) is not executed.







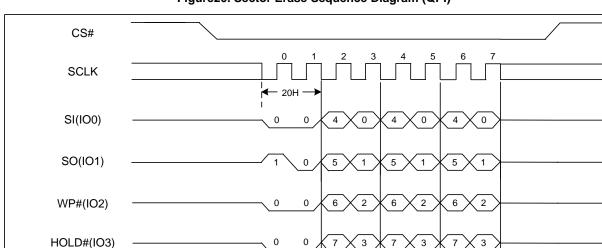


Figure 20. Sector Erase Sequence Diagram (QPI)

7.17. 32KB Block Erase (BE) (52H)

The 32KB Block Erase (BE) command is for erasing the all data of the chosen block. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit. The 32KB Block Erase (BE) command is entered by driving CS# low, followed by the command code, and three address bytes on SI. Any address inside the block is a valid address for the 32KB Block Erase (BE) command. CS# must be driven low for the entire duration of the sequence.

A23~A16

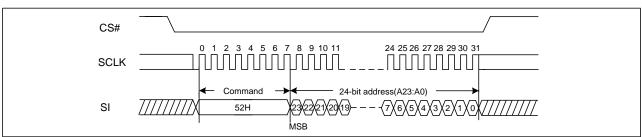
A15~A8

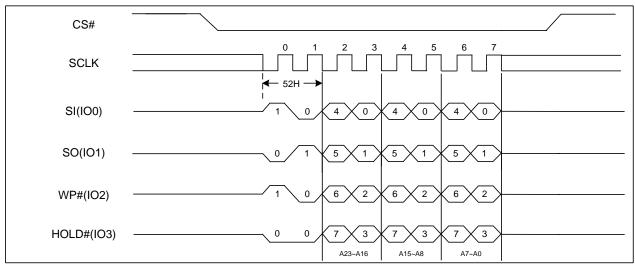
A7~A0

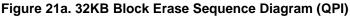
The 32KB Block Erase command sequence: CS# goes low->sending 32KB Block Erase command > 3-byte address on SI->CS# goes high. The command sequence is shown in Figure21. CS# must be driven high after the eighth bit of the last address byte has been latched in; otherwise the 32KB Block Erase (BE) command is not executed. As soon as CS# is driven high, the self-timed Block Erase cycle (whose duration is t_{BE}) is initiated. While the Block Erase cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Block Erase cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. A 32KB Block Erase (BE) command applied to a block which is protected by the Block Protect (BP4, BP3, BP2, BP1, BP0) bits (see Table1.0&1.1) is not executed.











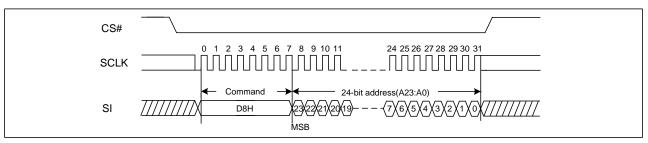
7.18. 64KB Block Erase (BE) (D8H)

The 64KB Block Erase (BE) command is for erasing the all data of the chosen block. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit. The 64KB Block Erase (BE) command is entered by driving CS# low, followed by the command code, and three address bytes on SI. Any address inside the block is a valid address for the 64KB Block Erase (BE) command. CS# must be driven low for the entire duration of the sequence.

The 64KB Block Erase command sequence: CS# goes low->sending 64KB Block Erase command > 3-byte address on SI->CS# goes high. The command sequence is shown in Figure22. CS# must be driven high after the eighth bit of the last address byte has been latched in; otherwise the 64KB Block Erase (BE) command is not executed. As soon as CS# is driven high, the self-timed Block Erase cycle (whose duration is t_{BE}) is initiated. While the Block Erase cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Block Erase cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. A 64KB Block Erase (BE) command applied to a block which is protected by the Block Protect (BP4, BP3, BP2, BP1, BP0) bits (see Table1.0&1.1) is not executed.







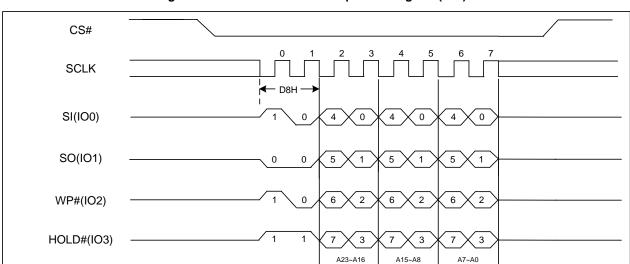


Figure22a. 64KB Block Erase Sequence Diagram (QPI)

7.19. Chip Erase (CE) (60/C7H)

The Chip Erase (CE) command is for erasing the all data of the chip. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit .The Chip Erase (CE) command is entered by driving CS# Low, followed by the command code on Serial Data Input (SI). CS# must be driven Low for the entire duration of the sequence.

The Chip Erase command sequence: CS# goes low \rightarrow sending Chip Erase command \rightarrow CS# goes high. The command sequence is shown in Figure23. CS# must be driven high after the eighth bit of the command code has been latched in, otherwise the Chip Erase command is not executed. As soon as CS# is driven high, the self-timed Chip Erase cycle (whose duration is t_{CE}) is initiated. While the Chip Erase cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Chip Erase cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. The Chip Erase (CE) command is executed if the Block Protect (BP2, BP1, BP0) bits are 0 and CMP=0 or the Block Protect (BP2,BP1,and BP0)bits are 1 and CMP=1. The Chip Erase (CE) command is ignored if one or more sectors are protected.



Figure 23. Chip Erase Sequence Diagram

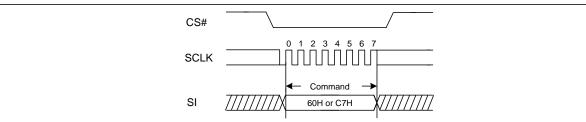
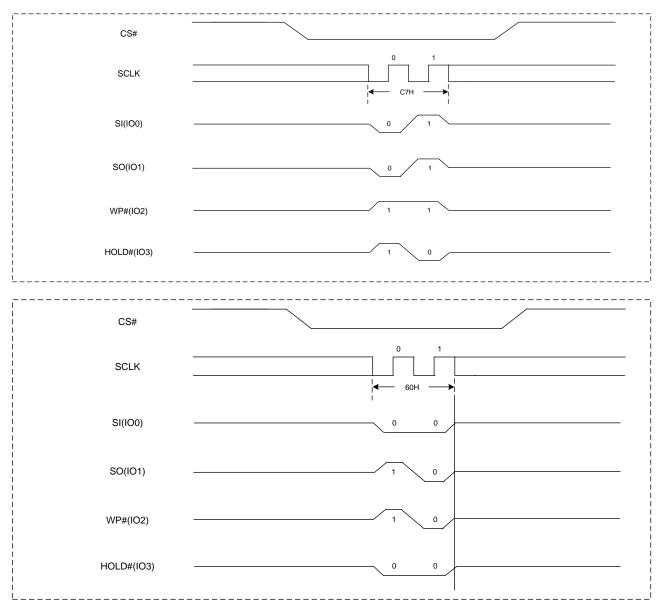


Figure23a. Chip Erase Sequence Diagram (QPI)



7.20. Deep Power-Down (DP) (B9H)

Executing the Deep Power-Down (DP) command is the only way to put the device in the lowest consumption mode (the Deep Power-Down Mode). It can also be used as an extra software protection mechanism, while the device is not in active use, since in this mode, the device ignores all Write, Program and Erase commands. Driving CS# high deselects the device, and puts the device in the Standby Mode (if there is no internal cycle currently in progress). But this mode is not the Deep Power-Down Mode. The Deep



Power-Down Mode can only be entered by executing the Deep Power-Down (DP) command. Once the device has entered the Deep Power-Down Mode, all commands are ignored except the Release from Deep Power-Down and Read Device ID (RDI) command. This releases the device from this mode. The Release from Deep Power-Down and Read Device ID (RDI) command also allows the Device ID of the device to be output on SO.

The Deep Power-Down Mode automatically stops at Power-Down, and the device always Power-Up in the Standby Mode. The Deep Power-Down (DP) command is entered by driving CS# low, followed by the command code on SI. CS# must be driven low for the entire duration of the sequence.

The Deep Power-Down command sequence: CS# goes low->sending Deep Power-Down command-> CS# goes high. The command sequence is shown in Figure24. CS# must be driven high after the eighth bit of the command code has been latched in; otherwise the Deep Power-Down (DP) command is not executed. As soon as CS# is driven high, it requires a delay of t_{DP} before the supply current is reduced to I_{CC2} and the Deep Power-Down Mode is entered. Any Deep Power-Down (DP) command, while an Erase, Program or Write cycle is in progress, is rejected without having any effects on the cycle that is in progress.

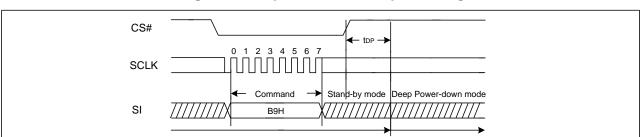
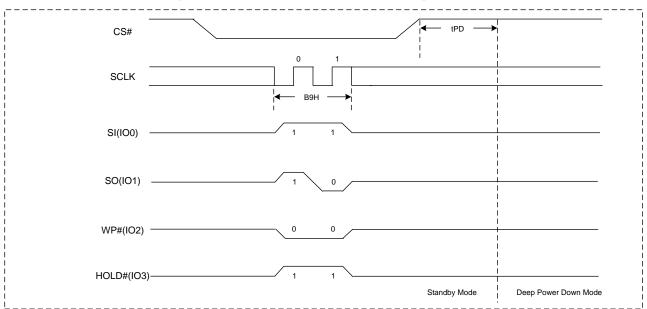


Figure 24. Deep Power-Down Sequence Diagram

Figure 24a. Deep Power-Down Sequence Diagram (QPI)



7.21. Release from Deep Power-Down And Read Device ID (RDI) (ABH)

The Release from Power-Down and Read/Device ID command is a multi-purpose command. It can be used to release the device from the Power-Down state or obtain the devices electronic identification (ID) number.

To release the device from the Power-Down state, the command is issued by driving the CS# pin low,



shifting the instruction code "ABH" and driving CS# high as shown in Figure25. Release from Power-Down will take the time duration of t_{RES1} (See AC Characteristics) before the device will resume normal operation and other command are accepted. The CS# pin must remain high during the t_{RES1} time duration.

When used only to obtain the Device ID while not in the Power-Down state, the command is initiated by driving the CS# pin low and shifting the instruction code "ABH" followed by 3-dummy byte. The Device ID bits are then shifted out on the falling edge of SCLK with most significant bit (MSB) first as shown in Figure26. The Device ID value for the FT25H64 is listed in Manufacturer and Device Identification table. The Device ID can be read continuously. The command is completed by driving CS# high. In QPI mode the dummy cycles can be configured by C0H command. When the dummy cycle is configured to 4, addr[0] input must be 0.

When used to release the device from the Power-Down state and obtain the Device ID, the command is the same as previously described, and shown in Figure25, except that after CS# is driven high it must remain high for a time duration of t_{RES2} (See AC Characteristics). After this time duration the device will resume normal operation and other command will be accepted. If the Release from Power-Down/Device ID command is issued while an Erase, Program or Write cycle is in process (when WIP equal 1) the command is ignored and will not have any effects on the current cycle.

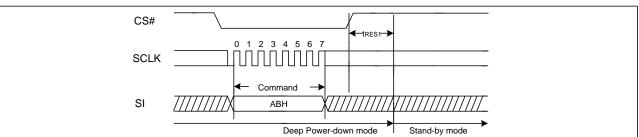
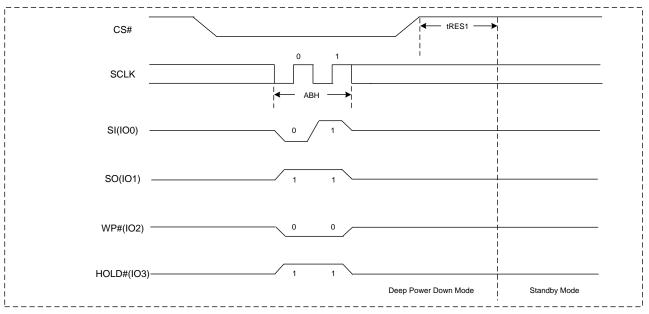
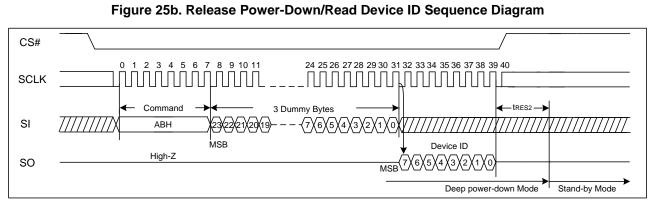




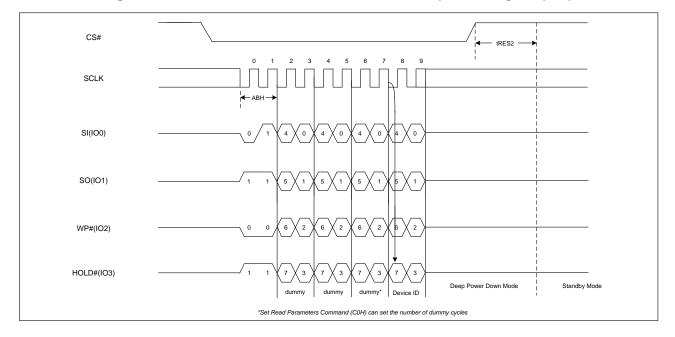
Figure 25a. Release Power-Down Sequence Diagram (QPI)









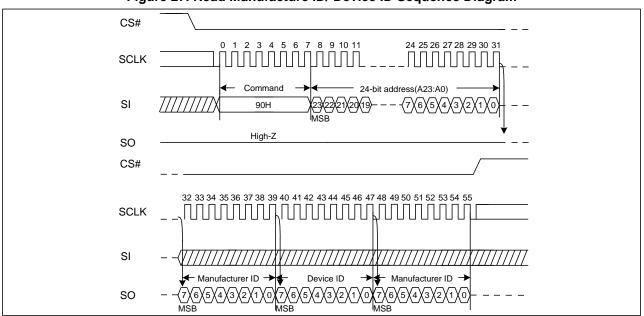




7.22. Read Manufacture ID/ Device ID (REMS) (90H)

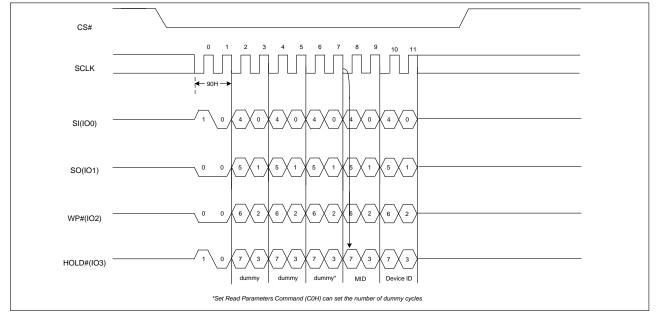
The Read Manufacturer/Device ID command is an alternative to the Release from Power-Down / Device ID command that provides both the JEDEC assigned Manufacturer ID and the specific Device ID.

The command is initiated by driving the CS# pin low and shifting the command code "90H" followed by a 24-bit address (A23-A0) of 000000H. After which, the Manufacturer ID and the Device ID are shifted out on the falling edge of SCLK with most significant bit (MSB) first as shown in Figure27. If the 24-bit address is initially set to 000001H, the Device ID will be read first. In QPI mode the dummy cycles can be configured by C0H command. When the dummy cycle is configured to 4, addr [0] input must be 0.







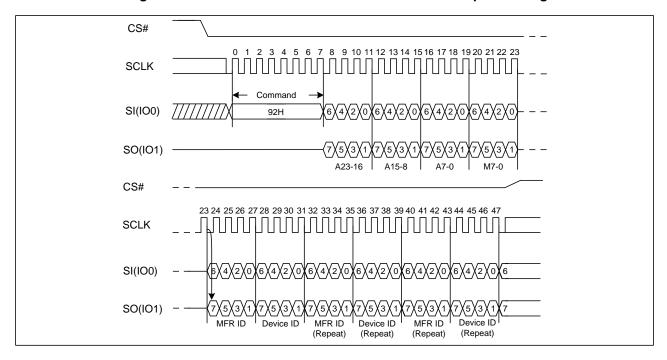




7.23. Read Manufacture ID/ Device ID Dual I/O (92H)

The Read Manufacturer/Device ID Dual I/O command is an alternative to the Release from Power-Down / Device ID command that provides both the JEDEC assigned Manufacturer ID and the specific Device ID by dual I/O.

The command is initiated by driving the CS# pin low and shifting the command code "92H" followed by a 24-bit address (A23-A0) of 000000H. After which, the Manufacturer ID and the Device ID are shifted out on the falling edge of SCLK with most significant bit (MSB) first as shown in Figure 28. If the 24-bit address is initially set to 000001H, the Device ID will be read first.





7.24. Read Manufacture ID/ Device ID Quad I/O (94H)

The Read Manufacturer/Device ID Quad I/O command is an alternative to the Release from Power-Down / Device ID command that provides both the JEDEC assigned Manufacturer ID and the specific Device ID by quad I/O.

The command is initiated by driving the CS# pin low and shifting the command code "94H" followed by a 24-bit address (A23-A0) of 000000H. After which, the Manufacturer ID and the Device ID are shifted out on the falling edge of SCLK with most significant bit (MSB) first as shown in Figure29. If the 24-bit address is initially set to 000001H, the Device ID will be read first.



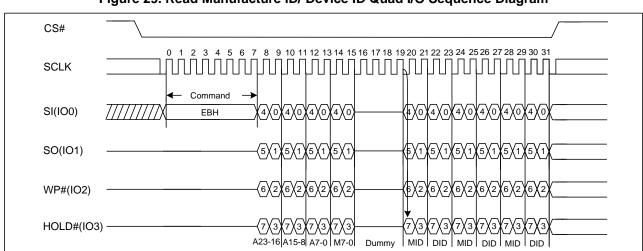


Figure 29. Read Manufacture ID/ Device ID Quad I/O Sequence Diagram

7.25. Read Identification (RDID) (9FH)

The Read Identification (RDID) command allows the 8-bit manufacturer identification to be read, followed by two bytes of device identification. The device identification indicates the memory type in the first byte, and the memory capacity of the device in the second byte. Any Read Identification (RDID) command while an Erase or Program cycle is in progress, is not decoded, and has no effect on the cycle that is in progress. The Read Identification (RDID) command should not be issued while the device is in Deep Power-Down Mode.

The device is first selected by driving CS# to low. Then, the 8-bit command code for the command is shifted in. This is followed by the 24-bit device identification, stored in the memory, being shifted out on Serial Data Output, each bit being shifted out during the falling edge of Serial Clock. The command sequence is shown in Figure30. The Read Identification (RDID) command is terminated by driving CS# to high at any time during data output. When CS# is driven high, the device is put in the Standby Mode. Once in the Standby Mode, the device waits to be selected, so that it can receive, decode and execute commands.

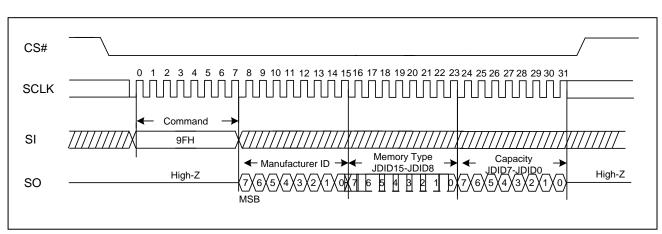


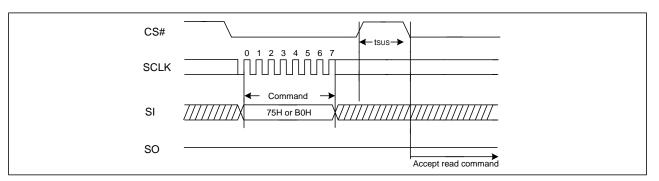
Figure 30. Read Identification ID Sequence Diagram



7.26. Program/Erase Suspend (PES) (75H or B0H)

The Program/Erase Suspend command "75H or B0H", allows the system to interrupt a page program or sector/block erase operation and then read data from any other sector or block. The Write Status Register command (01H) and Erase or Program Security Registers (44H, 42H) and Erase commands (20H, 52H, D8H, C7H, 60H) and Page Program command are not allowed during Program/Erase suspend. Program/Erase Suspend is valid only during the page program or sector/block erase operation. A maximum of time of "t_{SUS}" (See AC Characteristics) is required to suspend the program/erase operation.

The Program/Erase Suspend command will be accepted by the device only if the SUS bit in the Status Register equal to 0 and WIP bit equal to 1 while a Page Program or a Sector or Block Erase operation is on-going. If the SUS bit equal to 1 or WIP bit equal to 0, the Suspend command will be ignored by the device. The WIP bit will be cleared form 1 to 0 within " t_{SUS} " and the SUS bit will be set from 0 to 1 immediately after Program/Erase Suspend. A power-off during the suspend period will reset the device and release the suspend state. The command sequence is show in Figure 31.



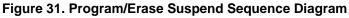
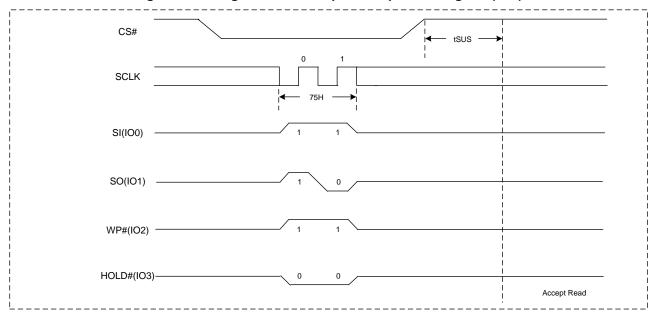
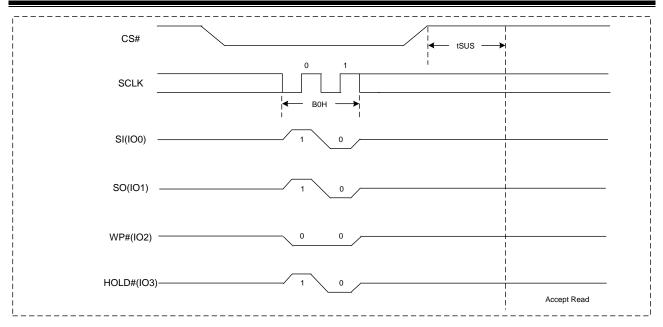


Figure 31a. Program/Erase Suspend Sequence Diagram (QPI)

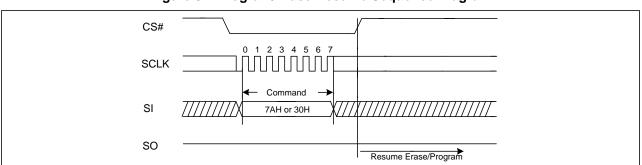






7.27. Program/Erase Resume (PER) (7AH or 30H)

The Program/Erase Resume command must be written to resume the program or sector/block erase operation after a Program/Erase Suspend command. The Program/Erase command will be accepted by the device only if the SUS bit equal to 1 and the WIP bit equal to 0. After issued the SUS bit in the status register will be cleared from 1 to 0 immediately, the WIP bit will be set from 0 to 1 within 200ns and the Sector or Block will complete the erase operation or the page will complete the program operation. The Program/Erase Resume command will be ignored unless a Program/Erase Suspend is active. The command sequence is show in Figure 32.







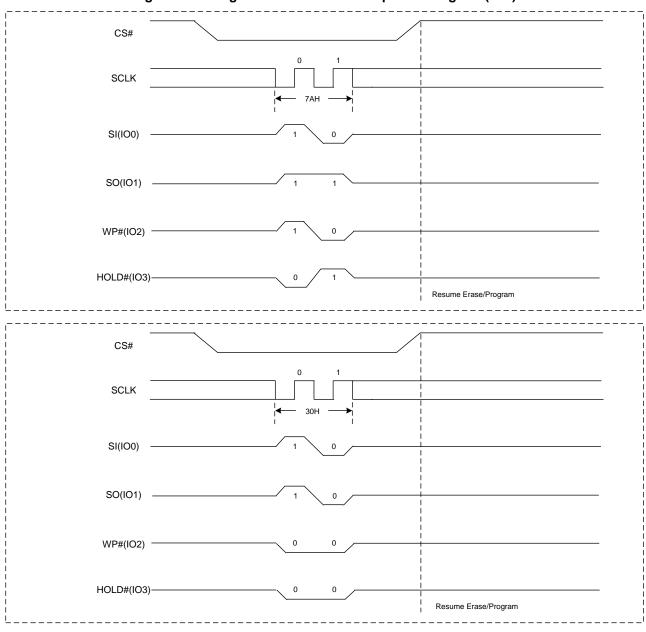


Figure 32a. Program/Erase Resume Sequence Diagram (QPI)

7.28. Erase Security Registers (44H)

The FT25H64 provides four 256-byte Security Registers which only erased all at once but able to programmed individually. These registers may be used by the system manufacturers to store security and other important information separately from the main memory array.

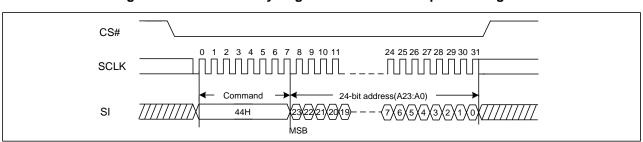
The Erase Security Registers command is similar to Sector/Block Erase command. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit.

The Erase Security Registers command sequence: CS# goes low \rightarrow sending Erase Security Registers command \rightarrow CS# goes high. The command sequence is shown in Figure33. CS# must be driven high after the eighth bit of the command code has been latched in, otherwise the Erase Security Registers command is not executed. As soon as CS# is driven high, the self-timed Erase Security Registers cycle (whose duration is t_{SE})



is initiated. While the Erase Security Registers cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Erase Security Registers cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset. The Security Registers Lock Bit (LB) in the Status Register can be used to OTP protect the security registers. Once the LB bit is set to 1, the Security Registers will be permanently locked; the Erase Security Registers command will be ignored.

Address	A23-A16	A15-A10	A9-A0
Security Registers	0000000	000000	Don't Care





7.29. Program Security Registers (42H)

The Program Security Registers command is similar to the Page Program command. It allows from 1 to 256 bytes Security Registers data to be programmed. A Write Enable (WREN) command must previously have been executed to set the Write Enable Latch (WEL) bit before sending the Program Security Registers command. The Program Security Registers command is entered by driving CS# Low, followed by the command code (42H), three address bytes and at least one data byte on SI. As soon as CS# is driven high, the self-timed Program Security Registers cycle (whose duration is t_{PP}) is initiated. While the Program Security Registers cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The Write In Progress (WIP) bit is 1 during the self-timed Program Security Registers cycle, and is 0 when it is completed. At some unspecified time before the cycle is completed, the Write Enable Latch (WEL) bit is reset.

If the Security Registers Lock Bit (LB) is set to 1, the Security Registers will be permanently locked. Program Security Registers command will be ignored.

Address	A23-A16	A15-A8	A7-A0
Security Registers 0	00H	00H	Byte Address
Security Registers 1	00H	01H	Byte Address
Security Registers 2	00H	02H	Byte Address
Security Registers 3	00H	03H	Byte Address



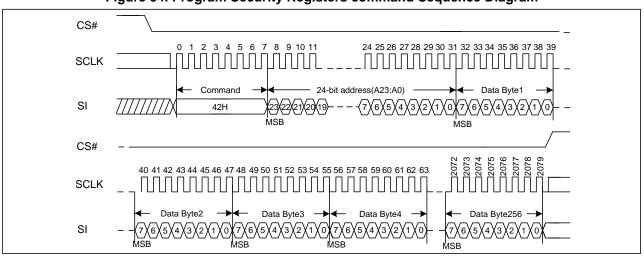


Figure 34. Program Security Registers command Sequence Diagram

7.30. Read Security Registers (48H)

The Read Security Registers command is similar to Fast Read command. The command is followed by a 3-byte address (A23-A0) and a dummy byte, each bit being latched-in during the rising edge of SCLK. Then the memory content, at that address, is shifted out on SO, each bit being shifted out, at a Max frequency f_c , during the falling edge of SCLK. The first byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out. Once the A9-A0 address reaches the last byte of the register (Byte 3FFH), it will reset to 000H, the command is completed by driving CS# high.

Address	A23-A16	A15-A10	A9-A0
Security Registers	00000000	000000	Address

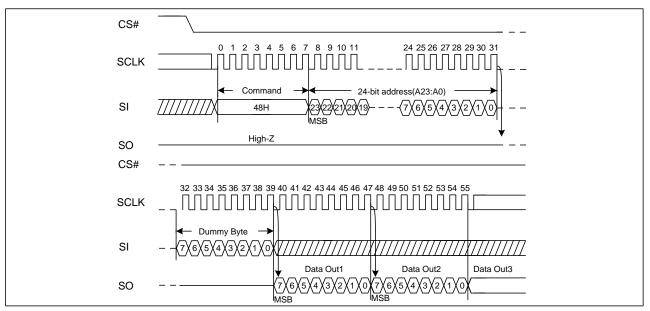


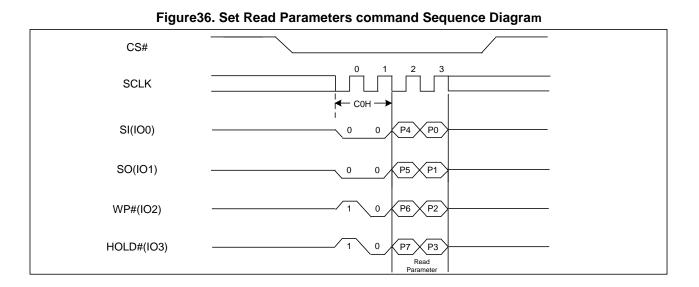
Figure 35. Read Security Registers command Sequence Diagram



7.31. Set Read Parameters (C0H)

In QPI mode the "Set Read Parameters (C0H)" command can be used to configure the number of dummy clocks for "Fast Read (0BH)", "Quad I/O Fast Read (EBH)" and "Burst Read with Wrap (0CH)" command, and to configure the number of bytes of "Wrap Length" for the "Burst Read with Wrap (0CH)" command. The "Wrap Length" is set by W5-6 bit in the "Set Burst with Wrap (77H)" command. This setting will remain unchanged when the device is switched from Standard SPI mode to QPI mode.

P5-P4	Dummy Clocks	Maximum	P1-P0	Wrap Length
0 0	4	80MHz	0 0	8-byte
0 1	4	80MHz	0 1	16-byte
10	6	96MHz	1 0	32-byte
1 1	8	108MHz	1 1	64-byte



7.32. Burst Read with Wrap (0CH)

The "Burst Read with Wrap (0CH)" command provides an alternative way to perform the read operation with "Wrap Around" in QPI mode. This command is similar to the "Fast Read (0BH)" command in QPI mode, except the addressing of the read operation will "Wrap Around" to the beginning boundary of the "Wrap Around" once the ending boundary is reached. The "Wrap Length" and the number of dummy clocks can be configured by the "Set Read Parameters (C0H)" command. When the dummy cycle is configured to 4, addr[0] input must be 0.



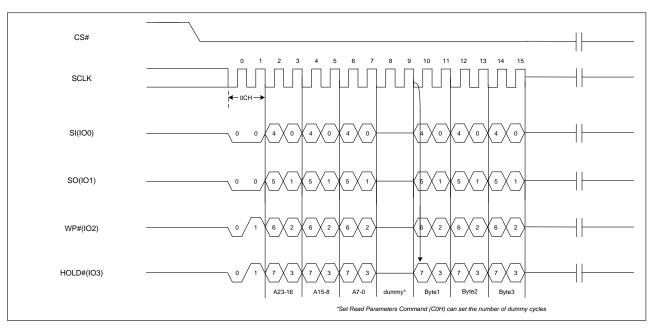
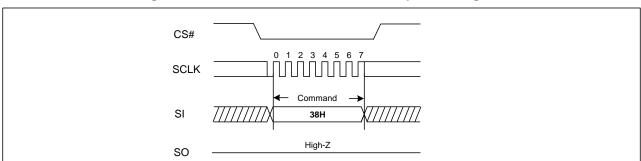
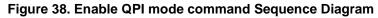


Figure 37. Burst Read with Wrap command Sequence Diagram

7.33. Enable QPI (38H)

The device support both Standard/Dual/Quad SPI and QPI mode. The "Enable QPI (38H)" command can switch the device from SPI mode to QPI mode. See the command Table 2a for all support QPI commands. In order to switch the device to QPI mode, the Quad Enable (QE) bit in Status Register-1 must be set to 1 first, and "Enable QPI (38H)" command must be issued. If the QE bit is 0, the "Enable QPI (38H)" command will be ignored and the device will remain in SPI mode. When the device is switched from SPI mode to QPI mode, the existing Write Enable Latch and Program/Erase Suspend status, and the Wrap Length setting will remain unchanged.





7.34. Continuous Read Mode Reset (CRMR) (FFH)/ Disable QPI (FFH)/

Continuous Read Mode Reset (CRMR) (FFH)

The Dual/Quad I/O Fast Read operations, "Continuous Read Mode" bits (M7-0) are implemented to further reduce command overhead. By setting the (M7-0) to AXH, the next Dual/Quad I/O Fast Read operations do not require the BBH/EBH/E7H command code.

Because the FT25H64 has no hardware reset pin, so if Continuous Read Mode bits are set to "AXH",



the FT25H64 will not recognize any standard SPI commands. So Continuous Read Mode Reset command will release the Continuous Read Mode from the "AXH" state and allow standard SPI command to be recognized. The command sequence is show in Figure 39.

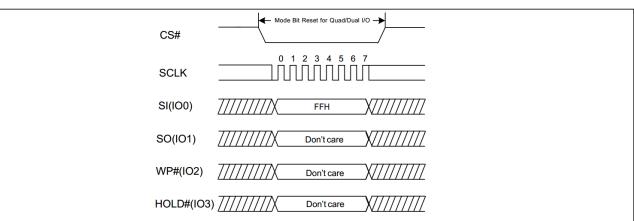
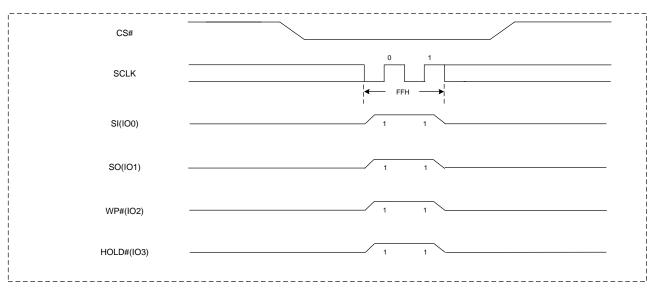


Figure 39. Continuous Read Mode Reset Sequence Diagram

Disable QPI (FFH)

To exit the QPI mode and return to Standard/Dual/Quad SPI mode, the "Disable QPI (FFH)" command must be issued. When the device is switched from QPI mode to SPI mode, the existing Write Enable Latch and Program/Erase Suspend status, and the Wrap Length setting will remain unchanged. When the device is in QPI mode, the first FFH command will exit continuous read mode and the second FFH command will exit QPI mode.

Figure39a. Disable QPI mode command Sequence Diagram



7.35. Enable Reset (66H) and Reset (99H)

If the Reset command is accepted, any on-going internal operation will be terminated and the device will return to its default power-on state and lose all the current volatile settings, such as Volatile Status Register bits, Write Enable Latch status (WEL), Program/Erase Suspend status, Read Parameter setting (P7-P0) and Wrap Bit Setting (W6-W4).

The "Reset (99H)" command sequence as follow: CS# goes low \rightarrow Sending Enable Reset command \rightarrow CS# goes high \rightarrow CS# goes low \rightarrow Sending Reset command \rightarrow CS# goes high. Once the Reset command is



accepted by the device, the device will take approximately t_{RST_R} to reset. During this period, no command will be accepted. Data corruption may happen if there is an on-going or suspended internal Erase or Program operation when Reset command sequence is accepted by the device. It is recommended to check the BUSY bit and the SUS bit in Status Register before issuing the Reset command sequence.

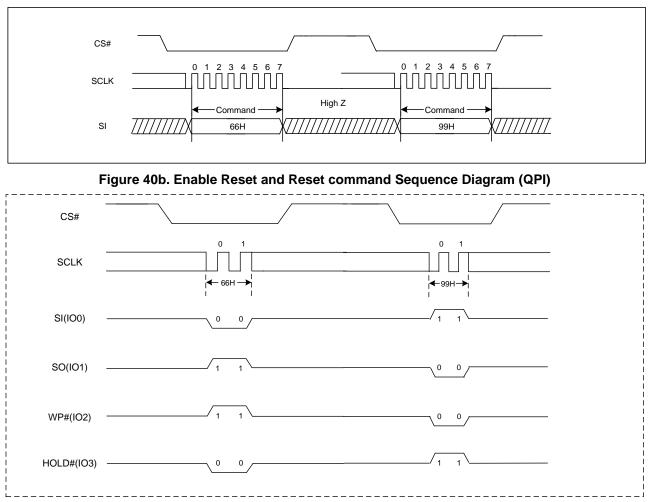


Figure 40a. Enable Reset and Reset command Sequence Diagram

7.36. Read Serial Flash Discoverable Parameter (5AH)

The Serial Flash Discoverable Parameter (SFDP) standard provides a consistent method of describing the functional and feature capabilities of serial flash devices in a standard set of internal parameter tables. These parameter tables can be interrogated by host system software to enable adjustments needed to accommodate divergent features from multiple vendors. The concept is similar to the one found in the Introduction of JEDEC Standard, JESD68 on CFI. SFDP is a standard of JEDEC Standard No.216.



Figure 41a. Read Serial Flash Discoverable Parameter command Sequence Diagram

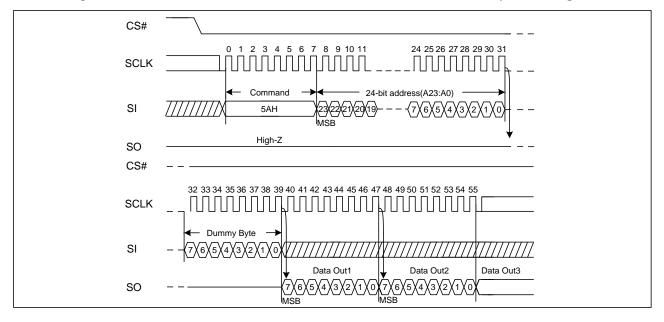


Figure 41b. Read Serial Flash Discoverable Parameter command Sequence Diagram (QPI)

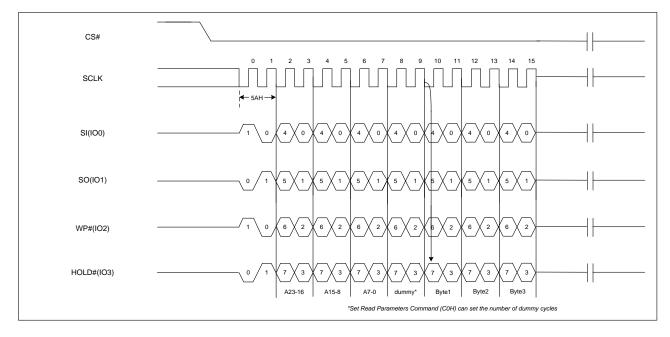




Table3. Signature and Parameter Identification Data Values

		V 억억(LI)	DW		
Description	Comment	Add(H) (Byte)	Add	Data	Data
		(Byte)	(Bit)		
		00H	07:00	53H	53H
SFDP Signature	Fixed:50444653H	01H	15:08	46H	46H
	FIXE0.3044403311	02H	23:16	44H	44H
			31:24	50H	50H
SFDP Minor Revision Number	Start from 00H	04H	07:00	00H	00H
SFDP Major Revision Number	Start from 01H	05H	15:08	01H	01H
Number of Parameters Headers	Start from 00H	06H	23:16	01H	01H
Unused	Contains 0xFFH and can never be	07H	31:24	FFH	FFH
onused	changed	071	31.24	ггп	ГГП
ID number (JEDEC)	00H: It indicates a JEDEC specified	08H	07:00	00H	00H
	header	0011	07.00	001	
Parameter Table Minor Revision	Start from 0x00H	09H	15:08	00H	00H
Number		0311	10.00	0011	0011
Parameter Table Major Revision	Start from 0x01H	0AH	23:16	01H	01H
Number		UAIT	20.10	0111	0111
Parameter Table Length	How many DWORDs in the	0BH	31:24	09H	09H
(in double word)	Parameter table	0011	01.21	0011	0011
	First address of JEDEC Flash	0CH	07:00	30H	30H
Parameter Table Pointer (PTP)	Parameter table	0DH	15:08	00H	00H
		0EH	23:16	00H	00H
Unused	Contains 0xFFH and can never be changed	0FH	31:24	FFH	FFH
ID Number (XTX FT series Manufacturer ID)	It indicates XTX FT series manufacturer ID	10H	07:00	0EH	0EH
Parameter Table Minor Revision Number	Start from 0x00H	11H	15:08	00H	00H
Parameter Table Major Revision Number	Start from 0x01H	12H	23:16	01H	01H
Parameter Table Length	How many DWORDs in the Parameter	4011	04.04	0011	0011
(in double word)	table	13H	31:24	03H	03H
	First address of VTV Flesh Decemptor	14H	07:00	60H	60H
Parameter Table Pointer (PTP)	First address of XTX Flash Parameter table	15H	15:08	00H	00H
		16H	23:16	00H	00H
Unused	Contains 0xFFH and can never be changed	17H	31:24	FFH	FFH



	frameter Table (0): JEDEC Flash	aramotor	1 46100	1	
Description	Comment	Add(H) (Byte)	DW Add (Bit)	Data	Data
	00: Reserved; 01: 4KB erase;		. ,		
Block/Sector Erase Size	10: Reserved;		01:00	01b	
Diock/Sector Liase Size	11: not support 4KB erase		01.00	015	
White Operation		-		41-	
Write Granularity	0: 1Byte, 1: 64Byte or larger		02	1b	
Write Enable Instruction	0: Nonvolatile status bit				
Requested for Writing to Volatile	1: Volatile status bit		03	0b	
Status Registers	(BP status register bit)	30H			E5H
	0: Use 50H Opcode,				
Write Enable Opcode Select for	1: Use 06H Opcode,				
Writing to Volatile Status Registers	Note: If target flash status register is		04	0b	
	Nonvolatile, then bits 3 and 4 must				
	be set to 00b.				
Linuard	Contains 111b and can never be		07.05	111b	
Unused	changed		07:05	TITD	
4KB Erase Opcode		31H	15:08	20H	20H
(1-1-2) Fast Read	0=Not support, 1=Support		16	1b	
Address Bytes Number used in	00: 3Byte only, 01: 3 or 4Byte,		10.17	0.01	
addressing flash array	10: 4Byte only, 11: Reserved		18:17	00b	
Double Transfer Rate (DTR)				_	
clocking	0=Not support, 1=Support	32H	19	0b	F1H
(1-2-2) Fast Read	0=Not support, 1=Support		20	1b	
(1-4-4) Fast Read	0=Not support, 1=Support		21	1b	
(1-1-4) Fast Read	0=Not support, 1=Support		22	1b	
Unused			23	1b	
Unused		33H	31:24	FFH	FFH
Flash Memory Density		37H:34H	31:00	007FF	FFFH
(1-4-4) Fast Read Number of	0 0000b: Wait states (Dummy				
Wait states	Clocks) not support		04:00	00100b	
(1-4-4) Fast Read Number of		38H			44H
Mode Bits	000b:Mode Bits not support		07:05	010b	
(1-4-4) Fast Read Opcode		39H	15:08	EBH	EBH
(1-1-4) Fast Read Number of	0 0000b: Wait states (Dummy				
Wait states	Clocks) not support		20:16	01000b	
(1-1-4) Fast Read Number of		3AH			08H
Mode Bits	000b:Mode Bits not support		23:21	000b	
(1-1-4) Fast Read Opcode		3BH	31:24	6BH	6BH
· · · · · · · · · · · · · · · · · · ·			- · · ·		

Table4. Parameter Table (0): JEDEC Flash Parameter Tables



(1-2-2) Fast Read Number of Wait states 20:16 00010b 42H (1-2-2) Fast Read Number of Mode Bits 3FH 31:24 BBH BBH BBH (1-2-2) Fast Read Opcode 0=not support 1=support 00 03:01 111b BBH Color 0.0 <th>Description</th> <th>Comment</th> <th>Add(H) (Byte)</th> <th>DW Add (Bit)</th> <th>Data</th> <th>Data</th>	Description	Comment	Add(H) (Byte)	DW Add (Bit)	Data	Data
(1-12) Fast Read Number of Mode Bits 000b: Mode Bits not support 07:05 000b (1-12) Fast Read Opcode 3DH 15:08 3BH 3BH (1-22) Fast Read Number of Wait states 3EH 3EH 20:16 0001bb (1-22) Fast Read Number of Mode Bits 3FH 31:24 BBH BBH (1-22) Fast Read Number of Mode Bits 0=not support 1=support 40H 03:01 111b (2-22) Fast Read 0=not support 1=support 40H 03:01 111b EEF (2-22) Fast Read 0=not support 1=support 40H 31:08 0xFFH 0xFF Unused 0 000b: Wait states (Durmmy clocks) not support 46H 20:16 0000b (2-2-2) Fast Read Number of Mode Bits 000b: Mode Bits not support 46H 20:16 0000bb (2-2-2) Fast Read Number of Mode Bits 000b: Mode Bits not support 46H 20:16 0000bb (2-2-2) Fast Read Number of Mode Bits 000b: Mode Bits not support 46H 23:21 000bb (4-4-4) Fast Read Number of Mode Bits 000b: Mode Bits not support			2011	04:00	01000b	0011
(1-2-2) Fast Read Number of Wait states 20:16 00010b 42H (1-2-2) Fast Read Number of Mode Bits 3FH 31:24 BBH BBF (1-2-2) Fast Read Opcode 3FH 31:24 BBH BBF (2-2) Fast Read 0=not support 1=support 40H 00 0b 03:01 111b (2-2-2) Fast Read 0=not support 1=support 40H 04 0b 03:01 111b Unused 0 0000b: Wait states 0000b 0xFFH 0xFH 0xFH 0xFH 0xFH		000b: Mode Bits not support	3CH	07:05	000b	08H
states 20:16 00010b 42H (1-2-2) Fast Read Number of Mode Bits 0=not support 1=support 3FH 31:24 BBH BBH (1-2-2) Fast Read Opcode 0=not support 1=support 00	(1-1-2) Fast Read Opcode		3DH	15:08	3BH	3BH
(1-2-2) Fast Read Number of Mode Bits 23:21 010b (1-2-2) Fast Read Opcode 0=not support 1=support 3FH 31:24 BBH BBF (2-2:2) Fast Read 0=not support 1=support 0 00 0 <td></td> <td></td> <td>0.511</td> <td>20:16</td> <td>00010b</td> <td>1011</td>			0.511	20:16	00010b	1011
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$			3EH	23:21	010b	42H
UnusedInternational (4-4-4) Fast ReadInternational (4-4-4) Fast ReadInternational (4-4-4) Fast ReadInternational (4-4-4) Fast ReadInternational (4-4-4) Fast Read Number of Wait (2-2-2) Fast Read Number of Wait (2-2-2) Fast Read Number of Mode Bits0 0000b: Wait states (Dummy (2-2-2) Fast Read Number of Mode (2-2-2) Fast Read Number of Mode (2-2-2) Fast Read Number of Mode Bits0 0000b: Wait states (Dummy (2-2-2) Fast Read Number of Mode (2-2-2) Fast Read Opcode000b: Mode Bits not support46HInternational (2-2-2) Fast Read Opcode000b: Mode Bits not support(2-2-2) Fast Read Opcode000b: Mode Bits not support47H31:24FFHFFH(4-4-4) Fast Read Opcode000b: Wait states (Dummy Clocks) not support49H:48H15:000xFFH0xFFH(4-4-4) Fast Read Number of Mode Bits000b: Mode Bits not support44H11:000xFFH0xFFH(4-4-4) Fast Read Number of Mode Bits000b: Mode Bits not support44H11:000xFFH0xFFH(4-4-4) Fast Read Number of Mode Bits000b: Mode Bits not support44H20:160000b00H(4-4-4) Fast Read Number of Mode DuxOb: this sector type don't exist4CH07:000CH0CHSector Type 1 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist4CH31:2452H52HSector Type 2 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist50H07:0010H10HSector Type 3 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist<	(1-2-2) Fast Read Opcode		3FH	31:24	BBH	BBH
(4-4-4) Fast Read0=not support 1=support40H040bEFUnused1007:05111b0xFFH </td <td>(2-2-2) Fast Read</td> <td>0=not support 1=support</td> <td></td> <td>00</td> <td>0b</td> <td></td>	(2-2-2) Fast Read	0=not support 1=support		00	0b	
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	Unused			03:01	111b	
InterformMathematical Mathematical<	(4-4-4) Fast Read	0=not support 1=support	40H	04	0b	EEH
UnusedImage of the term of t	Unused			07:05	111b	
$ \begin{array}{c c} (2-2-2) \ \mbox{Fast Read Number of Wald} \\ \mbox{states} & 0 \ 0000b: \ \mbox{Wait states} \ (Dummy \ Clocks) \ not \ support \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \$	Unused		43H:41H	31:08	0xFFH	0xFFH
statesClocks) not support $20:16$ $0000b$ $0000b$ (2-2-2) Fast Read Number of Mode Bits $000b:$ Mode Bits not support $46H$ $23:21$ $000b$ (2-2-2) Fast Read Opcode47H $31:24$ FFHFFHUnused49H:48H15:00 $0xFFH$ $0xFFH$ (4-4-4) Fast Read Number of Wait states $0000b:$ Wait states (Dummy Clocks) not support $44H$ $15:00$ $0xFFH$ $0xFFH$ (4-4-4) Fast Read Number of Mode Bits $000b:$ Mode Bits not support $44H$ $31:24$ FFH FFH (4-4-4) Fast Read Opcode $000b:$ Mode Bits not support $44H$ $31:24$ FFH FFH (4-4-4) Fast Read Opcode $000b:$ Mode Bits not support $44H$ $31:24$ FFH FFH Sector Type 1 SizeSector/block size=2^N bytes $0x00b:$ this sector type don't exist $4CH$ $07:00$ $0CH$ $0CH$ Sector Type 2 SizeSector/block size=2^N bytes $0x00b:$ this sector type don't exist $4EH$ $31:24$ $52H$ $52H$ Sector Type 3 SizeSector/block size=2^N bytes $0x00b:$ this sector type don't exist $52H$ $00H$ $00H$ Sector Type 3 SizeSector/block size=2^N bytes $0x00b:$ this sector type don't exist $52H$ $23:16$ $00H$ Sector Type 4 SizeSector/block size=2^N bytes $0x00b:$ this sector type don't exist $52H$ $23:16$ $00H$	Unused		45H:44H	15:00	0xFFH	0xFFH
(2-2-2) Fast Read Number of Mode Bits000b: Mode Bits not support46H23:21000b(2-2-2) Fast Read Opcode000b: Mode Bits not support47H31:24FFHFFHUnused49H:48H15:000xFFH0xFF0xFF(4-4-4) Fast Read Number of Wait states0 0000b: Wait states (Dummy Clocks) not support $4AH$ 15:00000b0000b(4-4-4) Fast Read Number of Mode Bits000b: Mode Bits not support $4AH$ $23:21$ 000b0000b(4-4-4) Fast Read Number of Mode Bits000b: Mode Bits not support $4AH$ $23:21$ 000b $000b$ (4-4-4) Fast Read Opcode000b: Mode Bits not support $4AH$ $31:24$ FFHFFHSector Type 1 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist $4CH$ $07:00$ $0CH$ $0CH$ Sector Type 2 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist $4EH$ $23:16$ $0FH$ $0FH$ Sector Type 2 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist $50H$ $07:00$ $0CH$ $0CH$ Sector Type 3 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist $50H$ $15:08$ $D8H$ $D8H$ Sector Type 4 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist $52H$ $23:16$ $00H$ $00H$				20:16	00000b	
Unused49H:48H15:000xFFH0xFF(4-4-4) Fast Read Number of Wait states0 0000b: Wait states (Dummy Clocks) not support $4AH$ $20:16$ 00000b $0000b$ (4-4-4) Fast Read Number of Mode Bits000b: Mode Bits not support $4AH$ $23:21$ 000b $000b$ (4-4-4) Fast Read Opcode000b: Mode Bits not support4BH $31:24$ FFHFFH(4-4-4) Fast Read Opcode4BH $31:24$ FFHFFHSector Type 1 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist4CH07:000CH0CHSector Type 2 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist4EH $23:16$ 0FH0FHSector Type 3 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist50H07:0010H10HSector Type 4 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist51H15:08D8HD8HSector Type 4 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist52H23:1600H00H			46H	23:21	000b	00H
(4-4-4) Fast Read Number of Wait states0 0000b: Wait states (Dummy Clocks) not supportAuth20:160000bb0000bb(4-4-4) Fast Read Number of Mode Bits000b: Mode Bits not support $4AH$ $23:21$ 000b $23:21$ 000b(4-4-4) Fast Read Opcode000b: Mode Bits not support4BH $31:24$ FFHFFHSector Type 1 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist4CH07:000CH0CHSector Type 2 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist4EH23:160FH0FHSector Type 3 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist50H07:0010H10HSector Type 3 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist50H07:0010H10HSector Type 4 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist51H15:08D8HD8HSector Type 4 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist52H23:1600H00H	(2-2-2) Fast Read Opcode		47H	31:24	FFH	FFH
statesClocks) not support $4AH$ $20:16$ $0000b$ $00H$ $(4-4-4)$ Fast Read Number of Mode Bits $000b:$ Mode Bits not support $4AH$ $23:21$ $000b$ $00H$ $(4-4-4)$ Fast Read Opcode $4BH$ $31:24$ FFH FFH $(4-4-4)$ Fast Read Opcode $4BH$ $31:24$ FFH FFH Sector Type 1 SizeSector/block size= 2^{AN} bytes $0x00b:$ this sector type don't exist $4CH$ $07:00$ $0CH$ $0CH$ Sector Type 2 SizeSector/block size= 2^{AN} bytes $0x00b:$ this sector type don't exist $4EH$ $23:16$ $0FH$ $0FH$ Sector Type 2 SizeSector/block size= 2^{AN} bytes $0x00b:$ this sector type don't exist $4EH$ $23:16$ $0FH$ $0FH$ Sector Type 2 erase OpcodeSector/block size= 2^{AN} bytes $0x00b:$ this sector type don't exist $50H$ $07:00$ $10H$ $10H$ Sector Type 3 SizeSector/block size= 2^{AN} bytes $0x00b:$ this sector type don't exist $50H$ $07:00$ $10H$ $10H$ Sector Type 4 SizeSector/block size= 2^{AN} bytes $0x00b:$ this sector type don't exist $52H$ $23:16$ $00H$ $00H$	Unused		49H:48H	15:00	0xFFH	0xFFH
(4-4-4) Fast Read Number of Mode Bits000b: Mode Bits not support23:21000b000b(4-4-4) Fast Read Opcode4BH31:24FFHFFH(4-4-4) Fast Read Opcode4BH31:24FFHFFHSector Type 1 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist4CH07:000CH0CHSector Type 1 erase Opcode4DH15:0820H20HSector Type 2 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist4EH23:160FH0FHSector Type 2 erase Opcode5ector/block size=2^N bytes 0x00b: this sector type don't exist60H10H10HSector Type 3 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist50H07:0010H10HSector Type 4 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist51H15:08D8HD8HSector Type 4 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist52H23:1600H00H			4411	20:16	00000b	0011
Sector Type 1 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist4CH07:000CH0CHSector Type 1 erase Opcode4DH15:0820H20HSector Type 2 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist4EH23:160FH0FHSector Type 2 erase Opcode4FH31:2452H52HSector Type 3 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist50H07:0010H10HSector Type 3 erase Opcode51H15:08D8HD8HSector Type 4 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist52H23:1600H00H		000b: Mode Bits not support	4AH	23:21	000b	00H
Sector Type 1 Size0x00b: this sector type don't exist4CH07:000CH0CHSector Type 1 erase Opcode4DH15:0820H20HSector Type 2 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist4EH23:160FH0FHSector Type 2 erase Opcode4FH31:2452H52HSector Type 3 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist50H07:0010H10HSector Type 3 erase Opcode51H15:08D8HD8HSector Type 4 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist52H23:1600H00H	(4-4-4) Fast Read Opcode		4BH	31:24	FFH	FFH
Sector Type 2 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist4EH23:160FH0FHSector Type 2 erase Opcode4FH31:2452H52HSector Type 3 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist50H07:0010H10HSector Type 3 erase Opcode51H15:08D8HD8HSector Type 4 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist52H23:1600H	Sector Type 1 Size	-	4CH	07:00	0CH	0CH
Sector Type 2 Size0x00b: this sector type don't exist4EH23:160FH0FHSector Type 2 erase Opcode4FH31:2452H52HSector Type 3 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist50H07:0010H10HSector Type 3 erase Opcode51H15:08D8HD8HSector Type 4 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist52H23:1600H00H	Sector Type 1 erase Opcode		4DH	15:08	20H	20H
Sector Type 3 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist50H07:0010H10HSector Type 3 erase Opcode51H15:08D8HD8HSector Type 4 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist52H23:1600H00H	Sector Type 2 Size		4EH	23:16	0FH	0FH
Sector Type 3 Size0x00b: this sector type don't exist50H07:0010H10HSector Type 3 erase Opcode51H15:08D8HD8HSector Type 4 SizeSector/block size=2^N bytes 0x00b: this sector type don't exist52H23:1600H00H	Sector Type 2 erase Opcode		4FH	31:24	52H	52H
Sector/block size=2^N bytes 0x00b: this sector type don't exist52H23:1600H00H	Sector Type 3 Size		50H	07:00	10H	10H
Sector Type 4 Size 0x00b: this sector type don't exist 52H 23:16 00H 00H	Sector Type 3 erase Opcode		51H	15:08	D8H	D8H
Sector Type 4 cross Opendo	Sector Type 4 Size		52H	23:16	00H	00H
Sector Type 4 erase Opcode 53H 31:24 FFH FFF	Sector Type 4 erase Opcode		53H	31:24	FFH	FFH



	arameter Table (1): XTX Flash Pa			1	1
Description	Comment	Add(H) (Byte)	DW Add (Bit)	Data	Data
		(Dyte)	(Dit)		
	2000H=2.000V				
Vcc Supply Maximum Voltage	2700H=2.700V	61H:60H	15:00	3600H	3600H
	3600H=3.600V				
	1650H=1.650V				
Vcc Supply Minimum Voltage	2250H=2.250V	63H:62H	31:16	2700H	2700H
vee cappiy winning verage	2300H=2.300V	0011.0211	01.10	270011	210011
	2700H=2.700V				
HW Reset# pin	0=not support 1=support		00	0b	
HW Hold# pin	0=not support 1=support		01	0b	
Deep Power Down Mode	0=not support 1=support		02	1b	
SW Reset	0=not support 1=support		03	0b	
	Should be issue Reset	05110411	44-04	0011	700 411
SW Reset Opcode	Enable(66H) before Reset cmd	65H:64H 	11:04	99H	7994H - -
Program Suspend/Resume	0=not support 1=support		12	1b	
Erase Suspend/Resume	0=not support 1=support		13	1b	
Unused			14	1b	
Wrap-Around Read mode	0=not support 1=support		15	0b	
Wrap-Around Read mode Opcode		66H	23:16	FFH	FFH
	08H:support 8B wrap-around read				
	16H:8B&16B				
Wrap-Around Read data length	32H:8B&16B&32B	67H	31:24	64H	64H
	64H:8B&16B&32B&64B				
Individual block lock	0=not support 1=support		00	0b	
Individual block lock bit					
(Volatile/Nonvolatile)	0=Volatile 1=Nonvolatile		01	0b	
Individual block lock Opcode		1	09:02	FFH	
Individual block lock Volatile		1	4.5	<i>.</i>	FAFAL
protect bit default protect status	0=protect 1=unprotect	6BH:68H	10	0b	E3FCH
Secured OTP	0=not support 1=support	1	11	0b	
Read Lock	0=not support 1=support	1	12	0b	
Permanent Lock	0=not support 1=support]	13	1b	
Unused		1	15:14	11b	
Unused		1	31:16	FFFFH	FFFFH

Table5. Parameter Table (1): XTX Flash Parameter Tables



8. ELECTRICAL CHARACTERISTICS

8.1. Power-on Timing

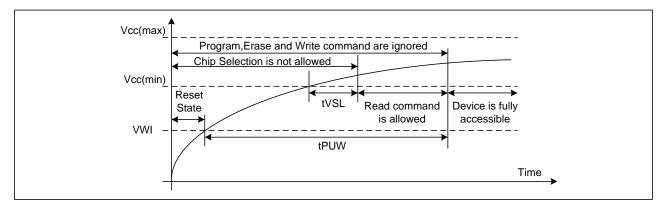


Table 6. Power-Up Timing and Write Inhibit Threshold

Symbol	Parameter	Min	Max	Unit
t _{VSL}	VCC(min) To CS# Low	10		ms
t _{PUW}	Time Delay Before Write Instruction	1	10	ms
V _{WI}	Write Inhibit Voltage	1	2.5	V

8.2. Initial Delivery State

The device is delivered with the memory array erased: all bits are set to 1(each byte contains FFH). The Status Register contains 00H (all Status Register bits are 0).

8.3. Data Retention and Endurance

Parameter	Туре	Unit
Minimum Pattern Data Retention Time	20	Years
Erase/Program Endurance	100K	Cycles

8.4. Latch up Characteristics

Parameter	Min	Max
Input Voltage Respect To VSS On I/O Pins	-1.0V	VCC+1.0V
VCC Current	-100mA	100mA



8.5. Absolute Maximum Ratings

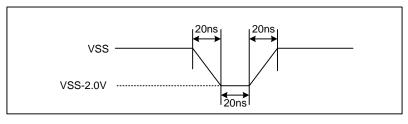
Parameter	Value	Unit
Ambient Operating Temperature	-40 to 85	°C
Storage Temperature	-65 to 150	°C
Output Short Circuit Current	200	mA
Applied Input/Output Voltage	-0.5 to 4.0	V
VCC	-0.5 to 4.0	V

8.6. Capacitance Measurement Condition

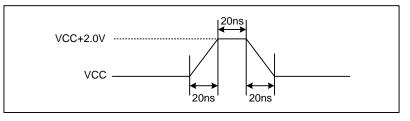
Symbol	Parameter	Min	Тур	Max	Unit	Conditions
C _{IN}	Input Capacitance			6	pF	VIN=0V
C _{OUT}	Output Capacitance			8	pF	VOUT=0V
CL	Load Capacitance		30		pF	
	Input Rise And Fall time			5	ns	
	Input Pulse Voltage	0.1V	CC to 0.8	VCC	V	
	Input Timing Reference Voltage	0.2VCC to 0.7VCC		V		
	Output Timing Reference Voltage	0.5VCC		V		

Figure 42. Input Test Waveform and Measurement Level

Maximum Negative Overshoot Waveform



Maximum Positive Overshoot Waveform





8.7. DC Characteristics

(T=-40°C~85°C,VCC=2.7~3.6V)

Symbol	Parameter	Test Condition	Min.	Тур	Max.	Unit
ILI	Input Leakage Current				±2	μA
I _{LO}	Output Leakage Current				±2	μA
l	Standby Current	CS#=VCC		12	20	μA
I _{CC1}	Standby Current	VIN=VCC or VSS		12	20	μΑ
I _{CC2}	Deep Power-Down Current	CS#=VCC		0.1	0.2	μA
1002	Deep I ower-Down Current	VIN=VCC or VSS		0.1	0.2	μΛ
		CLK=0.1VCC/0.9VCC at		15 20	20	mA
		120MHz, Q=Open(*1 I/O)			20	
		CLK=0.1VCC/0.9VCC at				
I _{CC3}	Operating Current(Read)	80MHz, Q=Open(*1,*2,*4		13	18	mA
		I/O)				
		CLK=0.1VCC/0.9VCC at		5	7	mA
		50MHZ,Q=Open(*1 I/O)		5	,	IIIA
I _{CC4}	Operating Current(PP)	CS#=VCC			10	mA
I _{CC5}	Operating Current(WRSR)	CS#=VCC			10	mA
I _{CC6}	Operating Current(SE)	CS#=VCC			10	mA
I _{CC7}	Operating Current(BE)	CS#=VCC			10	mA
VIL	Input Low Voltage		-0.5		0.2VCC	V
V _{IH}	Input High Voltage		0.7VCC		VCC+0.4	V
Vol	Output Low Voltage	IOL=1.6mA			0.4	V
V _{OH}	Output High Voltage	IOH=-100uA	VCC-0.2			V



8.8. AC Characteristics

 $(T=-40^{\circ}C \sim 85^{\circ}C, VCC=2.7 \sim 3.6V, C_{L}=30pF)$

Symbol	Parameter	Min.	Тур	Max.	Unit
4	Serial Clock Frequency For:Fast Read (0BH),			100	N411-
f _C	Dual Output(3BH)			108	MHz
4	Serial Clock Frequency For:Dual I/O (BBH),			109	MLI-
f _{C1}	Quad I/O(EBH),Quad Output(6BH)			108	MHz
f _{C2}	Serial Clock Frequency For QPI (0BH, EBH)			96	MHz
f _R	Serial Clock Frequency For: Read (03H), Read ID (9F)			80	MHz
t _{CLH}	Serial Clock High Time	5			ns
t _{CLL}	Serial Clock Low Time	5			ns
t _{CLCH}	Serial Clock Rise Time(Slew Rate)	0.2			V/ns
t _{CHCL}	Serial Clock Fall Time(Slew Rate)	0.2			V/ns
t _{SLCH}	CS# Active Setup Time	5			ns
t _{CHSH}	CS# Active Hold Time	5			ns
t _{shCH}	CS# Not Active Setup Time	5			ns
t _{CHSL}	CS# Not Active Hold Time	5			ns
t _{SHSL}	CS# High Time (read/write)	20			ns
t _{SHQZ}	Output Disable Time			6	ns
t _{CLQX}	Output Hold Time	1			ns
t _{DVCH}	Data In Setup Time	2			ns
t _{CHDX}	Data In Hold Time	2			ns
t _{HLCH}	Hold# Low Setup Time(relative to Clock)	5			ns
t _{HHCH}	Hold# High Setup Time(relative to Clock)	5			ns
t _{CHHL}	Hold# High Hold Time(relative to Clock)	5			ns
t _{СННН}	Hold# Low Hold Time(relative to Clock)	5			ns
t _{HLQZ}	Hold# Low To High-Z Output			6	ns
t _{HHQX}	Hold# Low To Low-Z Output			6	ns
t _{CLQV}	Clock Low To Output Valid			6.5	ns
t _{WHSL}	Write Protect Setup Time Before CS# Low	20			ns
t _{SHWL}	Write Protect Hold Time After CS# High	100			ns
t _{DP}	CS# High To Deep Power-Down Mode			0.1	us
	CS# High To Standby Mode Without Electronic				
t _{RES1}	Signature Read			20	us
	CS# High To Standby Mode With Electronic Signature				
t _{RES2}	Read			20	us
tsus	CS# High To Next Command After Suspend			20	us
t _{RST_R}	CS# High To Next Command After Reset (from read)			20	us
	CS# High To Next Command After Reset (from				
t _{RST_P}	program)			20	us
t _{RST_E}	CS# High To Next Command After Reset (from erase)			12	ms
t _W	Write Status Register Cycle Time		100	200	ms



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t _{PP}	Page Programming Time	0.25	0.7	ms
t _{SE}	Sector Erase Time	50	300	ms
t _{BE}	Block Erase Time(32K Bytes/64K Bytes)	0.15/0.25	0.5/0.75	S
t _{CE}	Chip Erase Time	20	60	s

Figure 43. Serial Input Timing

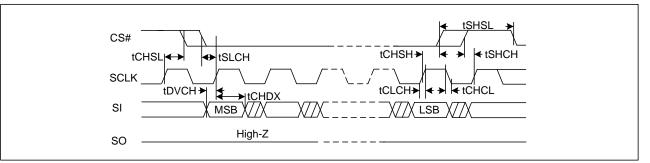


Figure 44. Output Timing

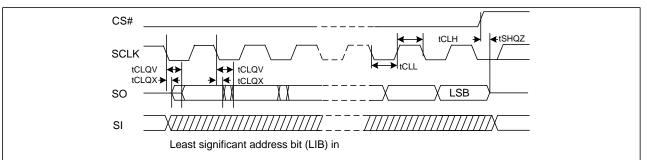
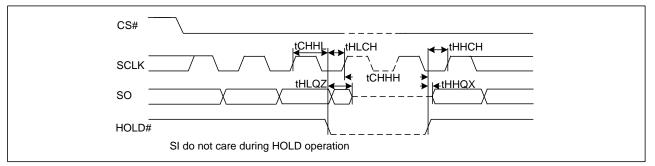


Figure 45. Hold Timing

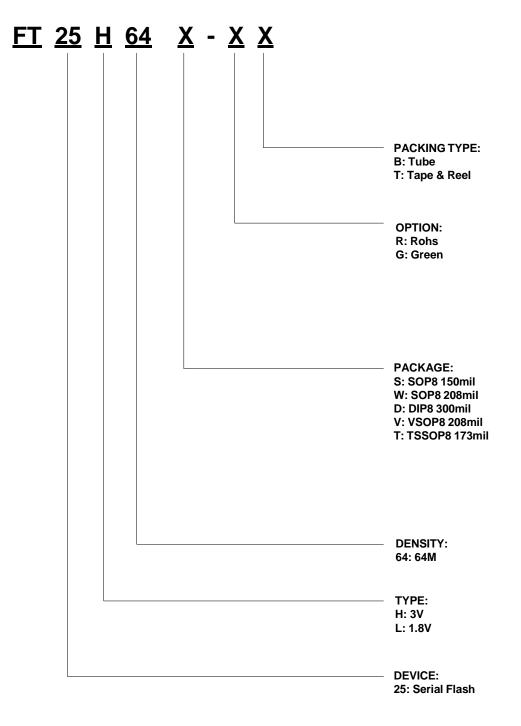


NOTE:

1. Standard bulk shipment is in Tube. Any alternation of packing method (for Tape, Reel and Tray etc.), please advise in advance.



9. ORDERING INFORMATION



NOTE:

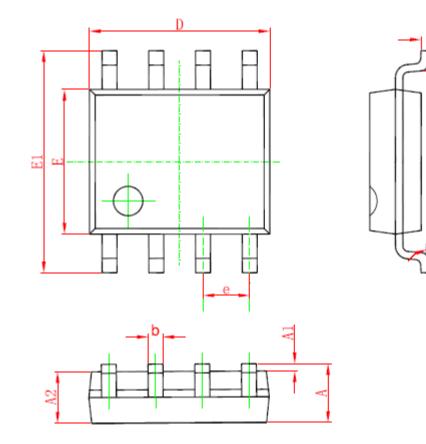
1. Standard bulk shipment is in Tube. Any alternation of packing method (for Tape, Reel and Tray etc.), please advise in advance.

С

θ

10. PACKAGE INFORMATION:

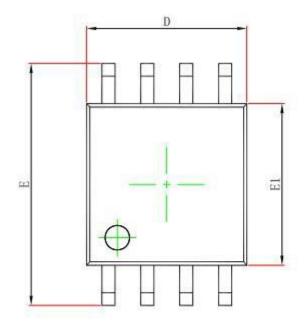
10.1. Package SOP8 150MIL

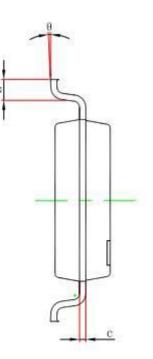


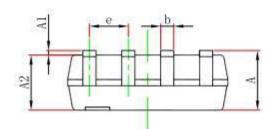
	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
А	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
с	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
Е	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270	(BSC)	0.050 (BSC)		
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



10.2. Package SOP8 208MIL



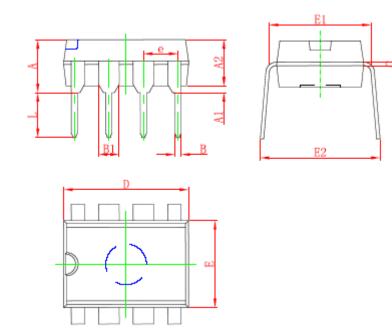




Symbol	Dimensions I	n Millimeters	Dimensions In Inches	
Symbol	Min	Мах	Min	Max
А		2.150		0.085
A1	0.050	0.250	0.002	0.010
A2	1.700	1.900	0.067	0.075
b	0.350	0.500	0.014	0.020
С	0.100	0.250	0.004	0.010
D	5.130	5.330	0.202	0.210
E	7.700	8.100	0.303	0.319
E1	5.180	5.380	0.204	0.212
е	1.270	(BSC)	0.050 (BSC)	
L	0.500	0.850	0.020	0.033
θ	0°	8°	0°	8°



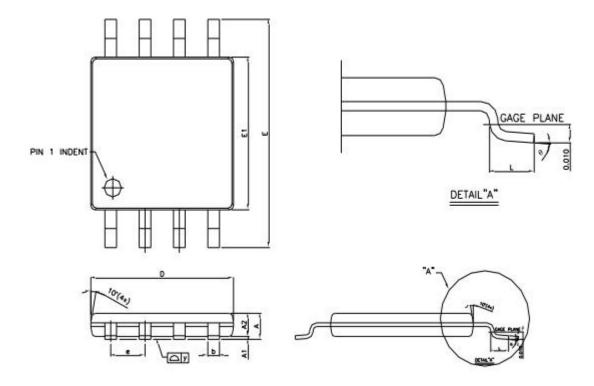
10.3. Package DIP8 300MIL



Symbol	Dimensions I	n Millimeters	Dimensions In Inches	
Cymbol	Min	Мах	Min	Max
А	3.710	4.310	0.146	0.170
A1	0.510		0.020	
A2	3.200	3.600	0.126	0.142
В	0.380	0.570	0.015	0.022
B1	1.524	(BSC)	0.060 (BSC)	
С	0.204	0.360	0.008	0.014
D	9.000	9.400	0.354	0.370
E	6.200	6.600	0.244	0.260
E1	7.320	7.920	0.288	0.312
е	2.540	(BSC)	0.100 (BSC)	
L	3.000	3.600	0.118	0.142
E2	8.400	9.000	0.331	0.354



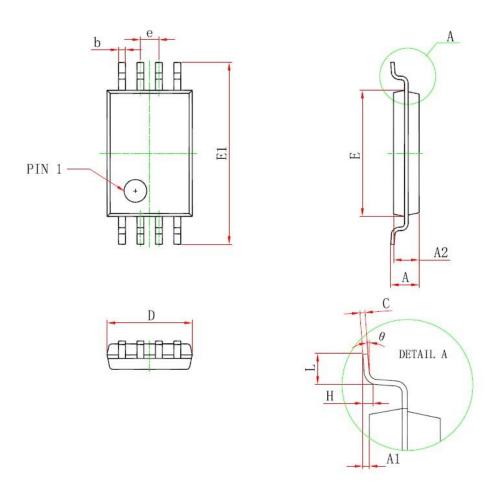
10.4. Package VSOP8 208MIL



Symbol	Dimensions I	n Millimeters	Dimensions In Inches	
Cymbol	Min	Max	Min	Max
А		1.000		0.039
A1	0.050	0.150	0.002	0.006
A2	0.750	0.850	0.030	0.033
b	0.350	0.480	0.014	0.019
С	0.127 (REF)		0.005 (REF)	
D	5.180	5.380	0.204	0.212
E	7.700	8.100	0.303	0.319
E1	5.180	5.380	0.204	0.212
е				
L	0.500	0.800	0.020	0.031
у		0.100		0.004
θ	0°	8°	0°	8°



10.5. Package TSSOP8 173MIL



Symbol	Dimensions I	n Millimeters	Dimension	s In Inches
Gymbol	Min	Мах	Min	Max
D	2.900	3.100	0.114	0.122
E	4.300	4.500	0.169	0.177
b	0.190	0.300	0.007	0.012
С	0.090	0.200	0.004	0.008
E1	6.250	6.550	0.246	0.258
А		1.200		0.047
A2	0.800	1.000	0.031	0.039
A1	0.050	0.150	0.002	0.006
е	0.65 ((BSC)	0.026 (BSC)	
L	0.500	0.700	0.020	0.028
Н	0.25 ((TYP)	0.01 (TYP)	
θ	1°	7°	1°	7°



11. REVISION HISTORY

Revision	Description	Date
0.0	Preliminary version	Jun 14, 2018



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